



RP131x SERIES

LOW ON RESISTANCE / LOW VOLTAGE 1A LDO

NO.EA-174-240417

OUTLINE

The RP131x Series are voltage-regulators with a built-in low ON-resistance transistor and output current is 1A capability. These ICs are capable of the low input voltage (Min.1.6V) and also the minimum output voltage can be set from 0.8V. (The output voltage is fixed in the IC.)

Each of these ICs consists of a voltage reference unit, an error amplifier, a resistor net for setting output voltage, a chip enable circuit, current limit circuits for over-current and short, and a thermal-shutdown circuit.

A standby mode with ultra low supply current can be realized with the chip enable function.

The packages for these ICs are DFN1616-6B and DFN(PL)1820-6 which are suitable for high density mounting of the ICs on boards. SOT-89-5, HSOP-6J and TO-252-5-P2 with high power dissipation are also available.

FEATURES

- Output Current Min. 1A
- Supply Current..... Typ. 65 μ A
- Standby Current Typ. 0.15 μ A
- Input Voltage Range 1.6V to 6.5V
- Output Voltage Range 0.8V to 5.5V ⁽¹⁾(0.1V steps)
- Dropout Voltage..... Typ. 0.5V ($V_{OUT}=2.8V$, $I_{OUT}=1A$)
- Ripple Rejection Typ. 70dB ($f=1kHz$, $V_{OUT}=2.8V$)
- Output Voltage Accuracy..... $\pm 1.0\%$
- Temperature-Drift Coefficient of Output Voltage..... Typ. $\pm 100ppm/^{\circ}C$
- Line Regulation..... Typ. 0.05%/V
- Load Regulation Typ. 20mV at $I_{OUT}=300mA$, Typ. 80mV at $I_{OUT}=1A$
- Packages DFN1616-6B, DFN(PL)1820-6, SOT-89-5, HSOP-6J, TO-252-5-P2
- Built-in Inrush current limit circuit Typ. 500mA
- Built-in Fold-Back Protection Circuit Typ. 250mA (Current at short mode)
- Built-in Thermal Shutdown Circuit Thermal Shutdown Temperature ; Typ. 165 $^{\circ}C$
Released Temperature ; Typ. 135 $^{\circ}C$
- Built-in Auto Discharge Function D version
- Ceramic capacitors are recommended to be used with this IC..... 2.2 μ F or more ($V_{OUT}\leq 3.6V$)
4.7 μ F or more ($V_{OUT}>3.6V$)

APPLICATIONS

- Power source for battery-powered equipment.
- Power source for portable communication equipment.
- Power source for electrical appliances such as cameras, VCRs and camcorders.
- Power source for Notebook PC.
- Power source for home appliances.

⁽¹⁾ For other voltages, please refer to MARK INFORMATION.

SELECTION GUIDE

The output voltage, auto discharge function, package for the ICs can be selected at the user's request.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RP131Lxx1*-TR	DFN1616-6B	5,000 pcs	Yes	Yes
RP131Kxx1*-TR	DFN(PL)1820-6	5,000 pcs	Yes	Yes
RP131Hxx1*-T1-FE	SOT-89-5	1,000 pcs	Yes	Yes
RP131Sxx1*-E2-FE	HSOP-6J	1,000 pcs	Yes	Yes
RP131Jxx1*-T1-FE	TO-252-5-P2	3,000 pcs	Yes	Yes

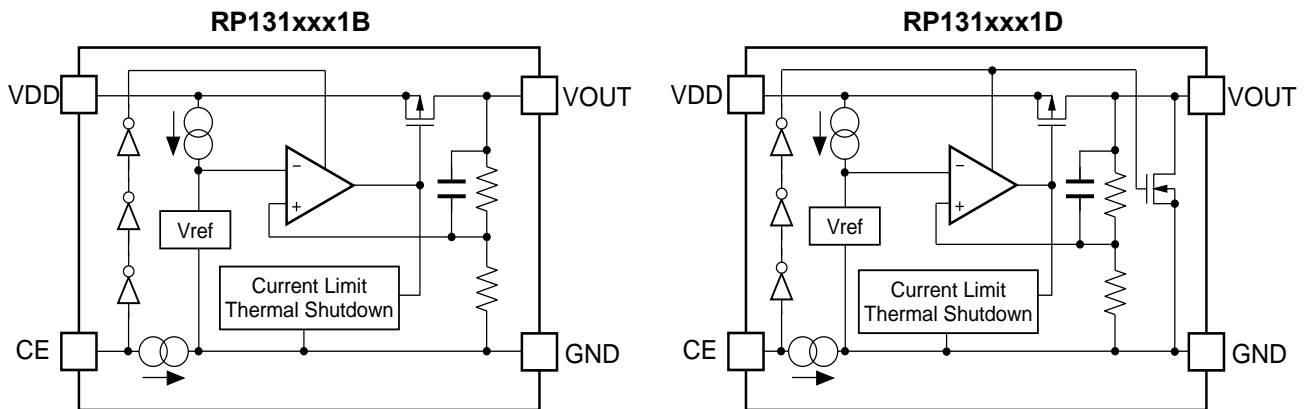
xx : The output voltage can be designated in the range from 0.8V(08) to 5.5V(55) in 0.1V steps.
(For other voltages, please refer to MARK INFORMATION.)

* : The auto discharge function at off state are options as follows.⁽¹⁾

(B) without auto discharge function at off state

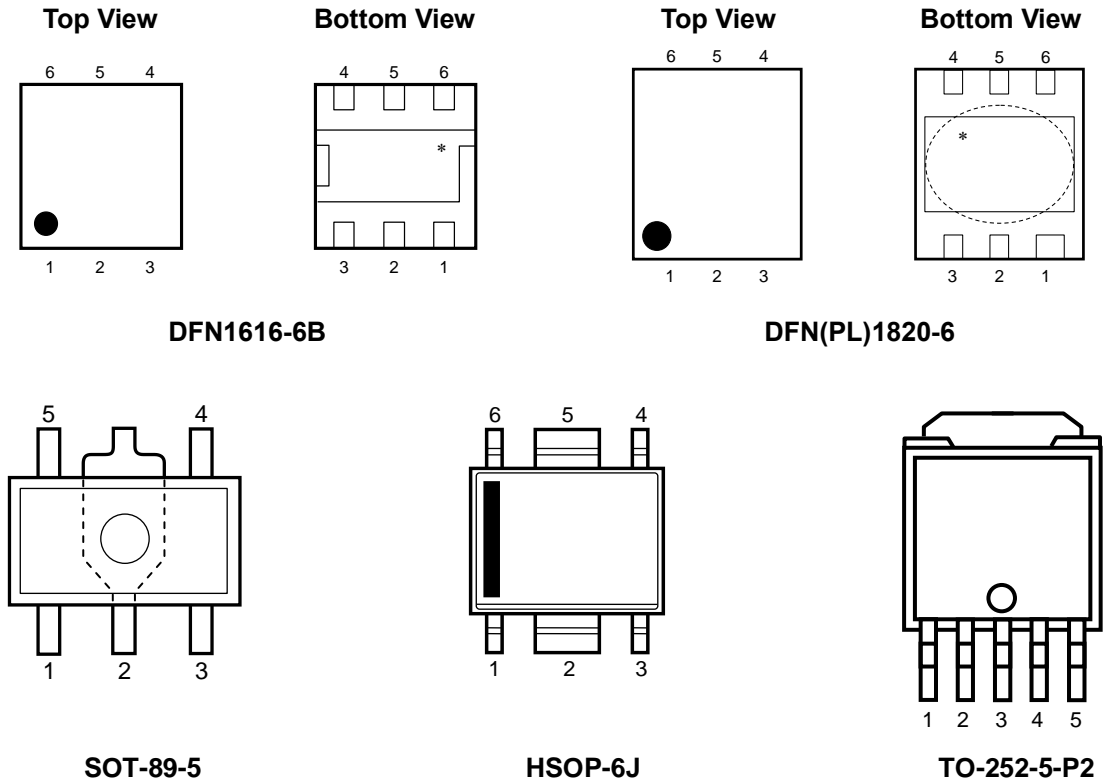
(D) with auto discharge function at off state

BLOCK DIAGRAMS



⁽¹⁾ Auto-discharge function quickly lowers the output voltage to 0V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.

PIN DESCRIPTIONS



*Tab is GND level. (They are connected to the reverse side of this IC.) The tab is better to be connected to the GND, but leaving it open is also acceptable.

RP131L (DFN1616-6B) Pin Description

Pin No.	Symbol	Pin Description
1	VOUT	Output Pin ⁽¹⁾
2	VOUT	Output Pin ⁽¹⁾
3	GND	Ground Pin
4	CE	Chip Enable Pin ("H" Active)
5	VDD	Input Pin ⁽¹⁾
6	VDD	Input Pin ⁽¹⁾

⁽¹⁾ When you use this IC, please make sure be wired with 1pin with 2pin and 5pin with 6pin.

RP131K (DFN(PL)1820-6) Pin Description

Pin No.	Symbol	Pin Description
1	VOUT	Output Pin ⁽¹⁾
2	VOUT	Output Pin ⁽¹⁾
3	GND	Ground Pin
4	CE	Chip Enable Pin ("H" Active)
5	VDD	Input Pin ⁽¹⁾
6	VDD	Input Pin ⁽¹⁾

RP131H (SOT-89-5) Pin Description

Pin No.	Symbol	Pin Description
1	NC	No Connection
2	GND	Ground Pin
3	CE	Chip Enable Pin ("H" Active)
4	VDD	Input Pin
5	VOUT	Output Pin

RP131S (HSOP-6J) Pin Description

Pin No.	Symbol	Pin Description
1	VOUT	Output Pin
2	GND	Ground Pin ⁽²⁾
3	NC	No Connection
4	CE	Chip Enable Pin ("H" Active)
5	GND	Ground Pin ⁽²⁾
6	VDD	Input Pin

RP131J (TO-252-5-P2) Pin Description

Pin No.	Symbol	Pin Description
1	VOUT	Output Pin
2	GND	Ground Pin ⁽³⁾
3	GND	Ground Pin ⁽³⁾
4	CE	Chip Enable Pin ("H" Active)
5	VDD	Input Pin

⁽¹⁾ When you use this IC, please make sure be wired with 1pin with 2pin and 5pin with 6pin.

⁽²⁾ When you use this IC, please make sure be wired with 2pin and 5pin.

⁽³⁾ When you use this IC, please make sure be wired with 2pin and 3pin.

ABSOLUTE MAXIMUM RATINGS

Symbol	Item		Rating	Unit
V_{IN}	Input Voltage		7.0	V
V_{CE}	Input Voltage (CE Pin)		-0.3 to 7.0	V
V_{OUT}	Output Voltage		-0.3 to $V_{IN}+0.3$	V
P_D	Power Dissipation ⁽¹⁾	DFN1616-6B	2400	mW
		DFN(PL)1820-6	2200	
		SOT-89-5	2600	
		HSOP-6J	2700	
		TO-252-5-P2	3800	
T_j	Junction Temperature Range		-40 to 125	°C
T_{stg}	Storage Temperature Range		-55 to 125	°C

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	1.6 to 6.5	V
T_a	Operating Temperature Range	-40 to 85	°C

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such ratings by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

⁽¹⁾ Refer to POWER DISSIPATION for detailed information.

ELECTRICAL CHARACTERISTICS

$V_{IN} = \text{Set } V_{OUT} + 1V, I_{OUT} = 1mA$

The specification in is checked and guaranteed by design engineering at $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$, unless otherwise noted.

RP131xxx1B/D

($T_a = 25^{\circ}\text{C}$)

Symbol	Item	Conditions		Min.	Typ.	Max.	Unit
V _{OUT}	Output Voltage	T _a = 25°C	V _{OUT} >1.5V	×0.99		×1.01	V
			V _{OUT} ≤1.5V	−15		15	mV
		−40°C ≤ T _a ≤ 85°C	V _{OUT} >1.5V	×0.974		×1.018	V
			V _{OUT} ≤1.5V	−40		27	mV
ΔV _{OUT} /ΔI _{OUT}	Load Regulation	0.1mA ≤ I _{OUT} ≤ 300mA			20	40	mV
		0.1mA ≤ I _{OUT} ≤ 1A			80	120	
V _{DIF}	Dropout Voltage	Refer to the following table					
I _{SS}	Supply Current	I _{OUT} =0mA (V _{IN} =6.5V)			65	90	μA
I _{standby}	Standby Current	V _{CE} =0V, V _{IN} =6.5V			0.15	0.60	μA
ΔV _{OUT} /ΔV _{IN}	Line Regulation	Set V _{OUT} +0.5V ≤ V _{IN} ≤ 6.5V *However, V _{IN} ≥ 1.6V			0.05	0.1	%/V
RR	Ripple Rejection	f=1kHz Ripple 0.2Vp-p I _{OUT} =100mA	V _{OUT} ≤3.3V		70		dB
			V _{OUT} >3.3V		60		
V _{IN}	Input Voltage			1.6		6.5	V
I _{LIM}	Output Current Limit			1			A
ΔV _{OUT} /ΔT _a	Output Voltage Temperature Coefficient	−40°C≤T _a ≤85°C			±100		ppm /°C
I _{SC}	Short Current Limit	V _{OUT} =0V			250		mA
I _{PD}	CE Pull-down Current				0.3		μA
V _{CEH}	CE Input Voltage "H"			1.0			V
V _{CEL}	CE Input Voltage "L"					0.4	V
en	Output Noise	BW=10Hz to 100kHz, I _{OUT} =1mA			45		μVrms
T _{TSD}	Thermal Shutdown Temperature	Junction Temperature			165		°C
T _{TSR}	Thermal Shutdown Released Temperature	Junction Temperature			135		°C
R _{LOW}	Low Output Nch Tr. ON Resistance (of D version)	V _{IN} =4.0V, V _{CE} =0V			30		Ω

All test items listed under Electrical Characteristics are done under the pulse load condition ($T_j \approx T_a = 25^{\circ}\text{C}$) except for Output Noise, Ripple Rejection, Output Voltage Temperature Coefficient, Dropout Voltage at 1A Output Current and Thermal Shutdown items.

The specification in ☐ is checked and guaranteed by design engineering at $-40^{\circ}\text{C} \leq T_a \leq 85^{\circ}\text{C}$, unless otherwise noted.

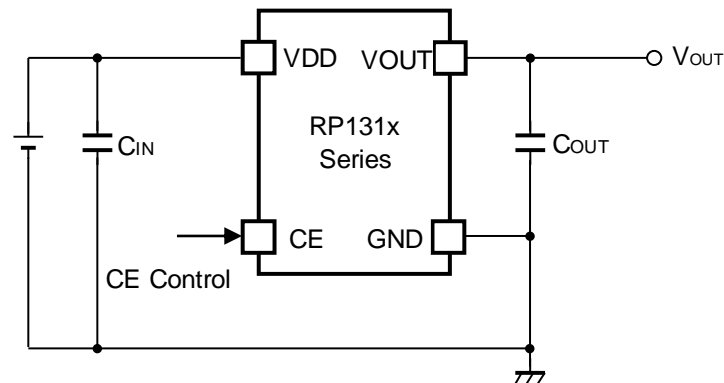
Dropout Voltage

($T_a = 25^{\circ}\text{C}$)

Output Voltage V_{OUT} (V)	Dropout Voltage V_{DIF} (V)					
	Condition	Typ.	Max.	Condition	Typ.	Max.
$0.8 \leq V_{\text{OUT}} < 0.9$	$I_{\text{OUT}}=300\text{mA}$	0.600	<input type="checkbox"/> 0.780	$I_{\text{OUT}}=1\text{A}$	1.100	<input type="checkbox"/> 1.650
$0.9 \leq V_{\text{OUT}} < 1.0$		0.550	<input type="checkbox"/> 0.690		1.050	<input type="checkbox"/> 1.500
$1.0 \leq V_{\text{OUT}} < 1.1$		0.450	<input type="checkbox"/> 0.610		1.000	<input type="checkbox"/> 1.450
$1.1 \leq V_{\text{OUT}} < 1.2$		0.340	<input type="checkbox"/> 0.540		0.930	<input type="checkbox"/> 1.420
$1.2 \leq V_{\text{OUT}} < 1.5$		0.290	<input type="checkbox"/> 0.500		0.900	<input type="checkbox"/> 1.380
$1.5 \leq V_{\text{OUT}} < 2.6$		0.230	<input type="checkbox"/> 0.310		0.700	<input type="checkbox"/> 1.100
$2.6 \leq V_{\text{OUT}} < 3.3$		0.150	<input type="checkbox"/> 0.180		0.500	<input type="checkbox"/> 0.750
$3.3 \leq V_{\text{OUT}} \leq 5.5$		0.140	<input type="checkbox"/> 0.170		0.450	<input type="checkbox"/> 0.650

APPLICATION INFORMATION

Typical Application Circuits



Recommendation value of the external capacitors

V_{OUT}	Capacitors		
$V_{OUT} \leq 3.6V$	C_{IN}	Kyocera 2.2 μF (size:1005)	[CM05X5R225M06AB]
	C_{OUT}	Kyocera 2.2 μF (size:1608)	[CM105X5R225K06AB]
$V_{OUT} > 3.6V$	C_{IN}	Kyocera 2.2 μF (size:1608)	[CM105X5R225K06AB]
	C_{OUT}	Kyocera 4.7 μF (size:1608)	[CM105X5R475M06AB]

Technical Notes on the External Components

When using this IC, consider following points:

Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a capacitor C_{OUT} with good frequency characteristics and ESR (Equivalent Series Resistance).

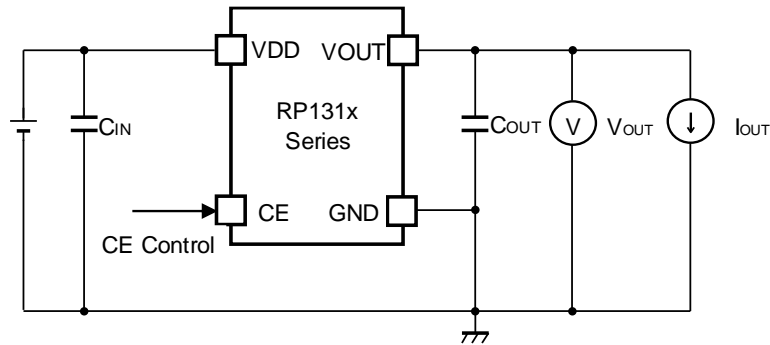
If a tantalum capacitor is used, and its ESR of C_{OUT} is large, the loop oscillation may result. Because of this, select C_{OUT} carefully considering its frequency characteristics.

PCB Layout

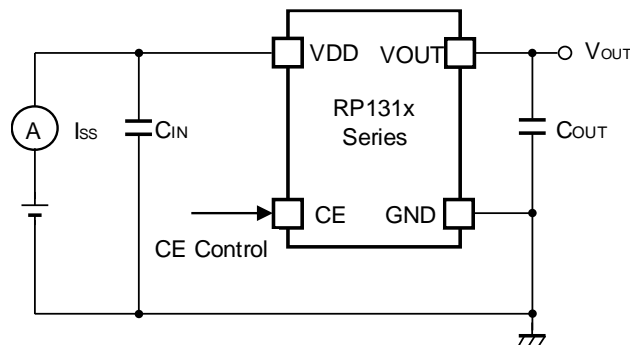
Make VDD and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor C_{IN} between VDD and GND pin with a capacitance value as "Recommendation value of the external capacitors" above or more, and as close as possible to the pins.

Set external components, especially the output capacitor C_{OUT} , as close as possible to the ICs, and make wiring as short as possible.

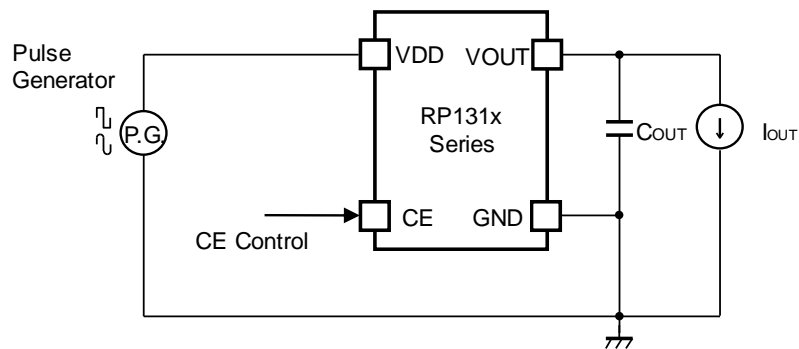
TEST CIRCUITS



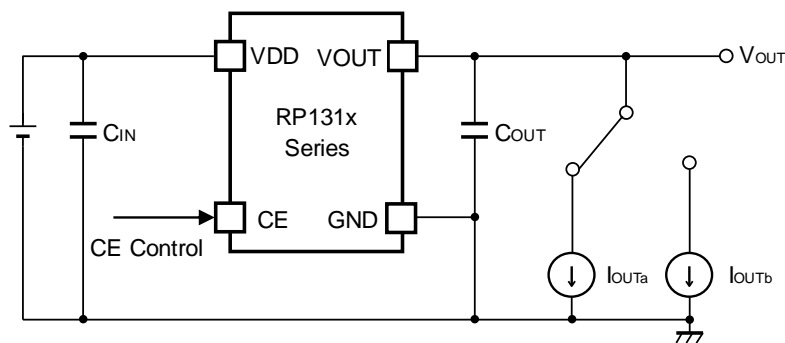
Basic Test Circuit



Test Circuit for Supply Current



Test Circuit for Ripple Rejection



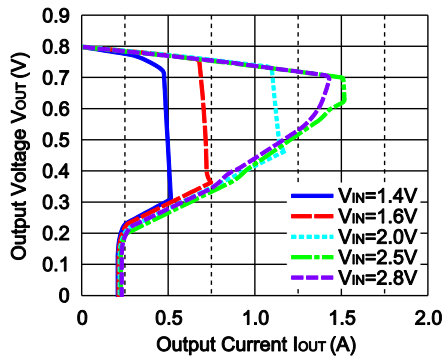
Test Circuit for Load Transient Response

TYPICAL CHARACTERISTICS

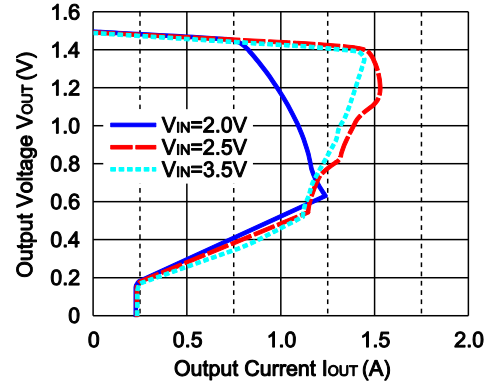
Typical Characteristics are intended to be used as reference data; they are not guaranteed.

1) Output Voltage vs. Output Current ($T_a = 25^\circ\text{C}$)

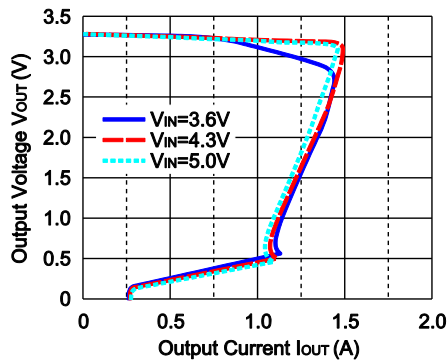
RP131x081x



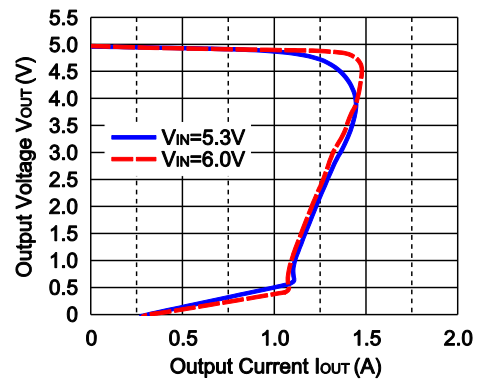
RP131x151x



RP131x331x

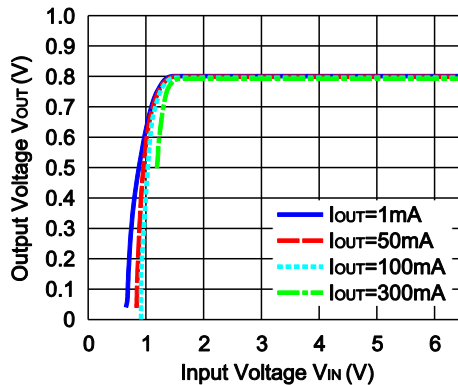


RP131x501x

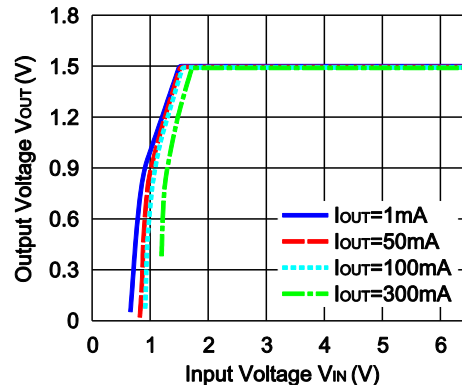


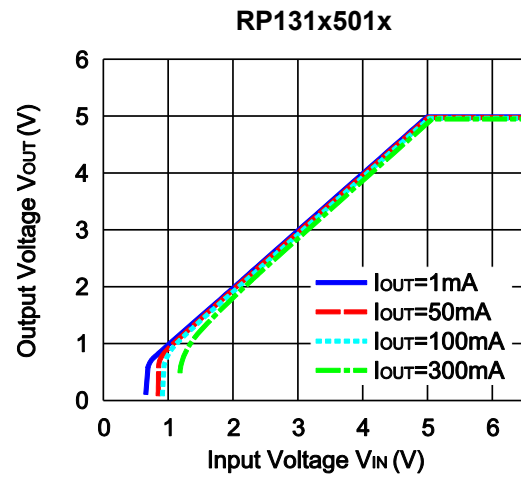
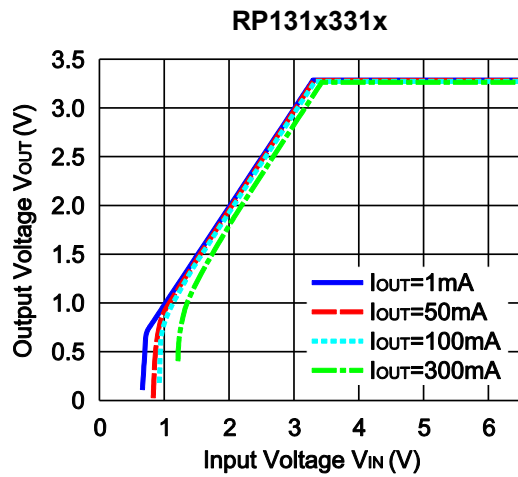
2) Output Voltage vs. Input Voltage ($T_a = 25^\circ\text{C}$)

RP131x081x

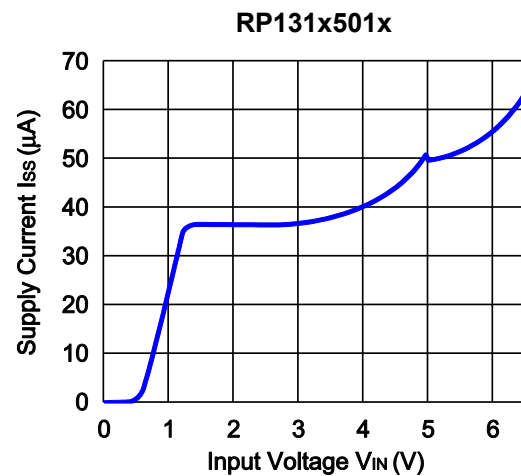
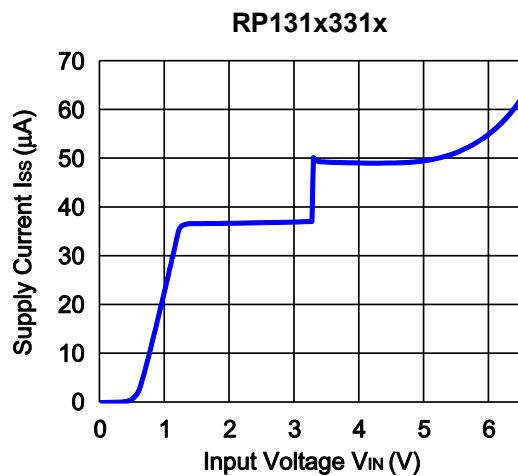
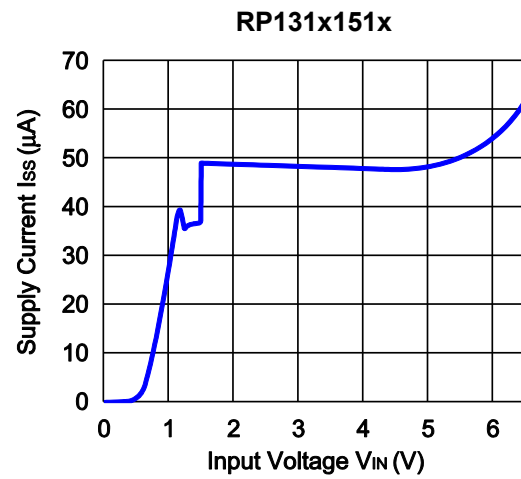
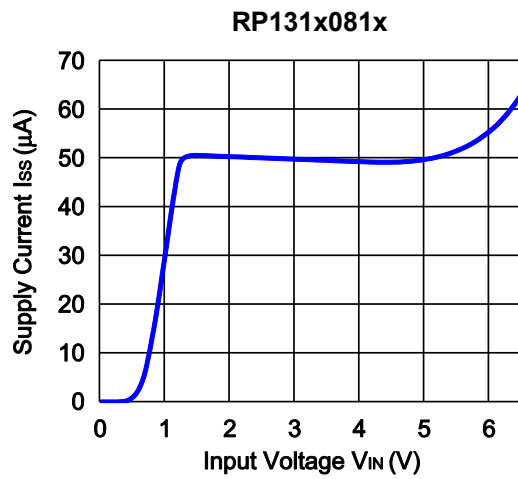


RP131x151x

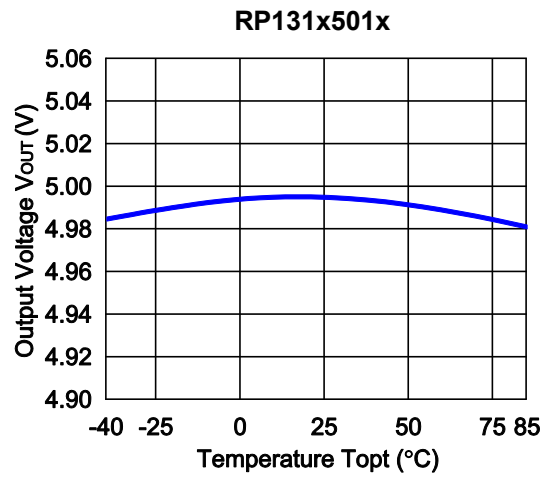
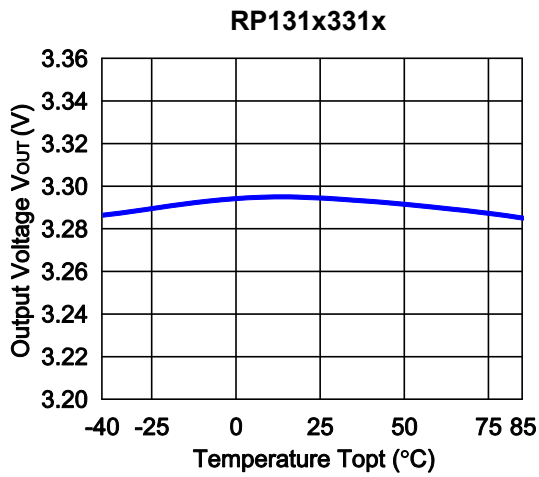
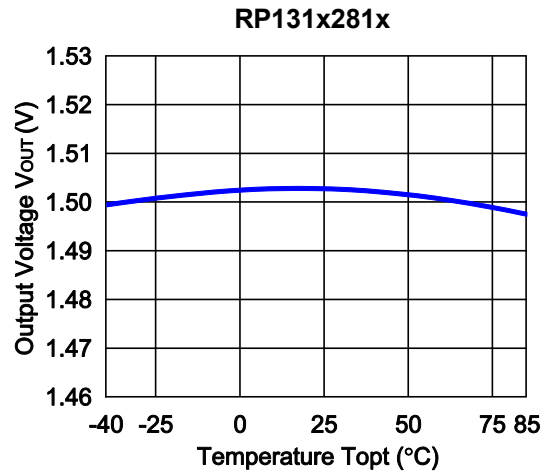
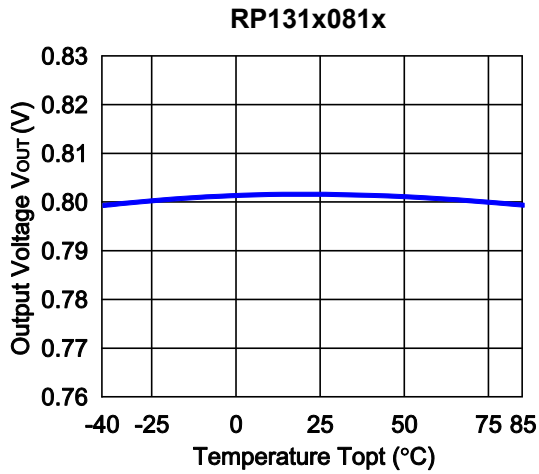




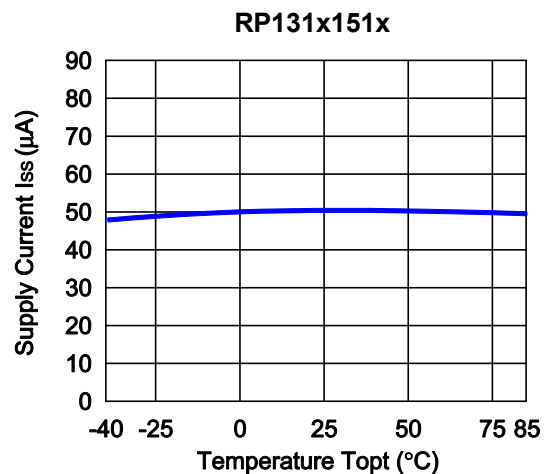
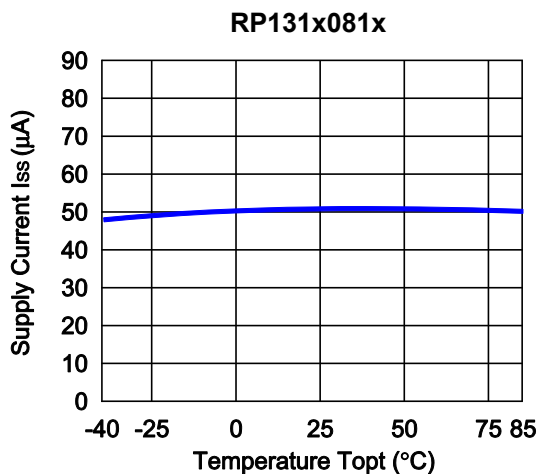
3) Supply Current vs. Input Voltage ($T_a=25^\circ\text{C}$)

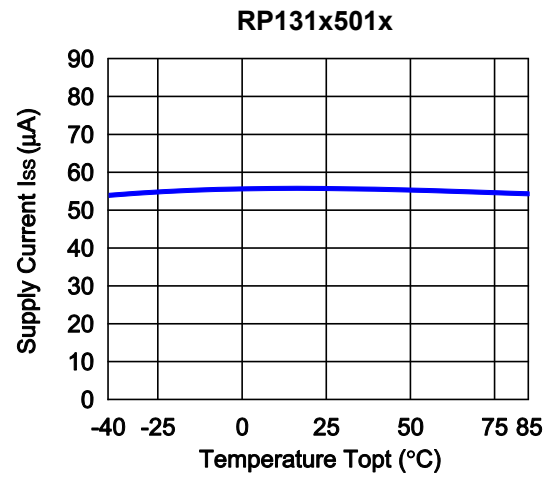
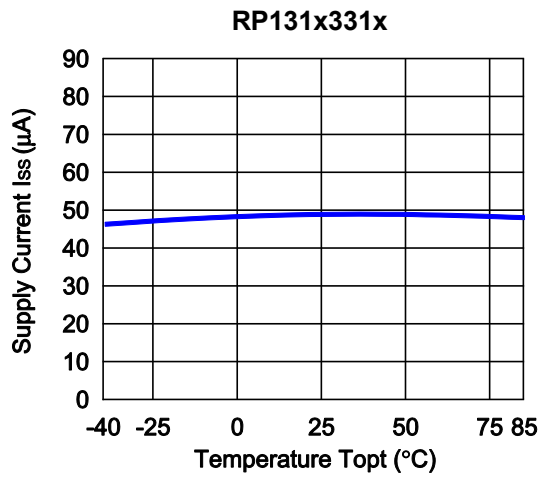


4) Output Voltage vs. Temperature

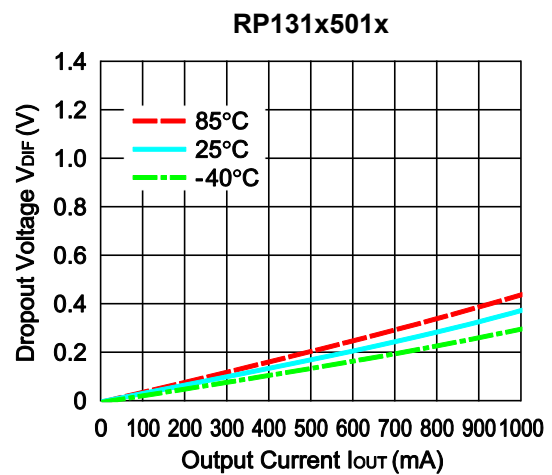
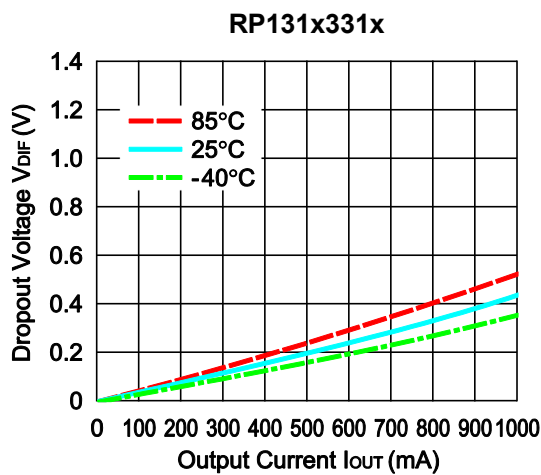
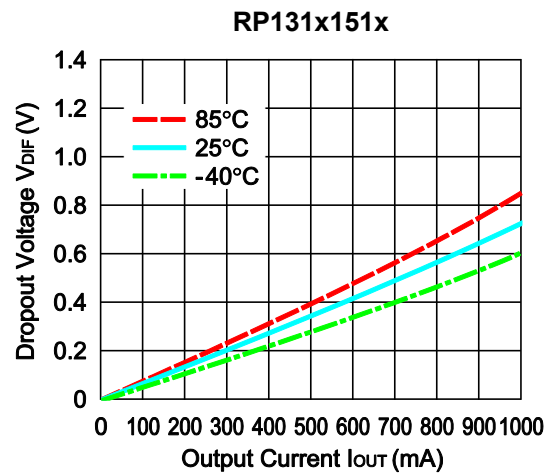
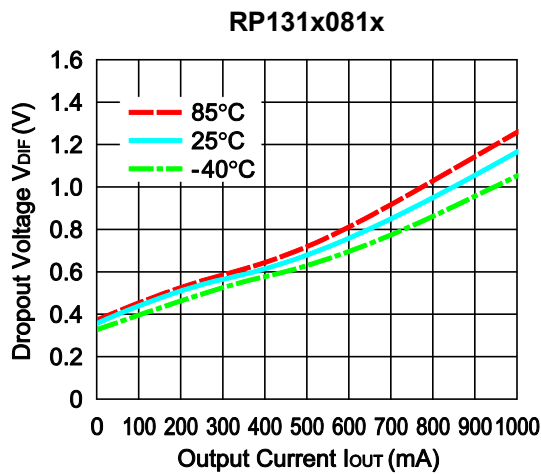


5) Supply Current vs. Temperature

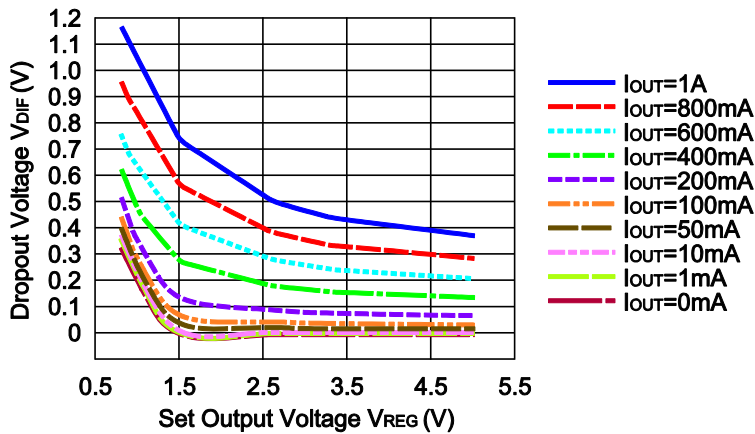




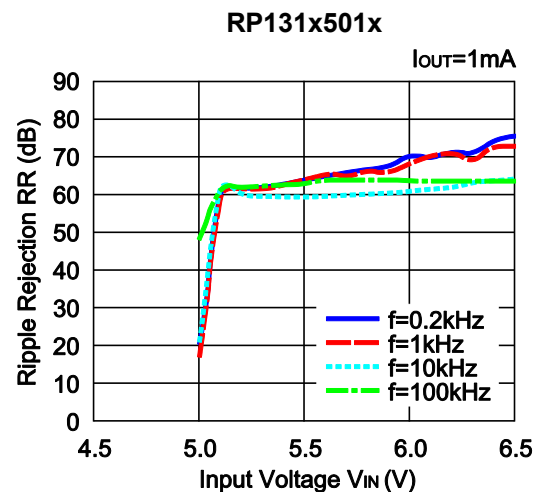
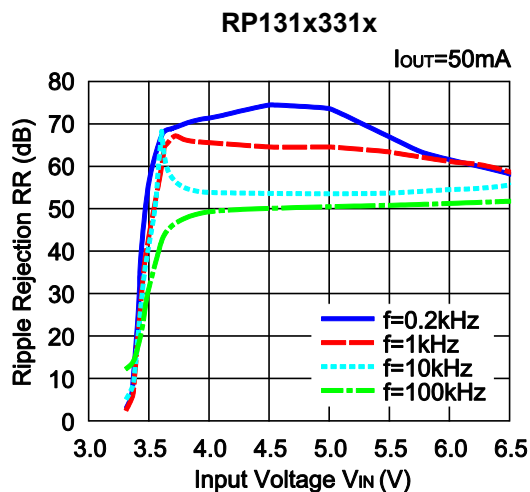
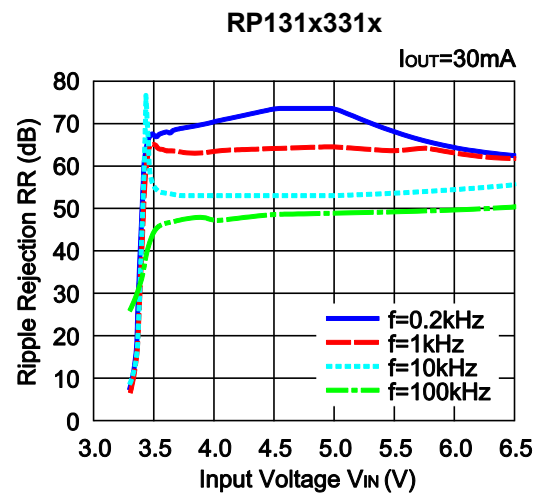
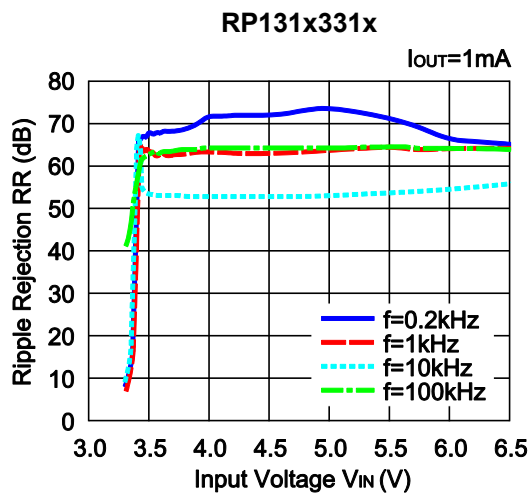
6) Dropout Voltage vs. Output Current

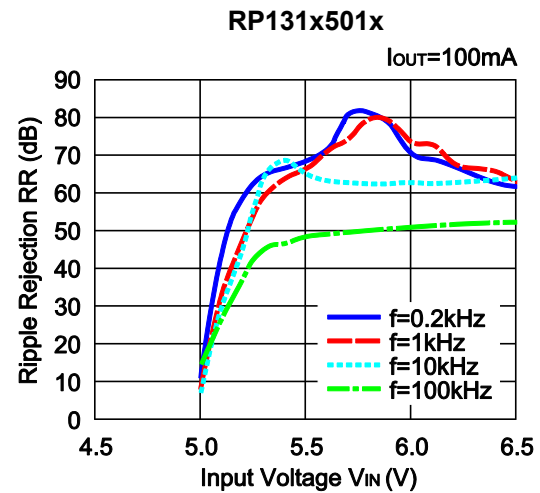
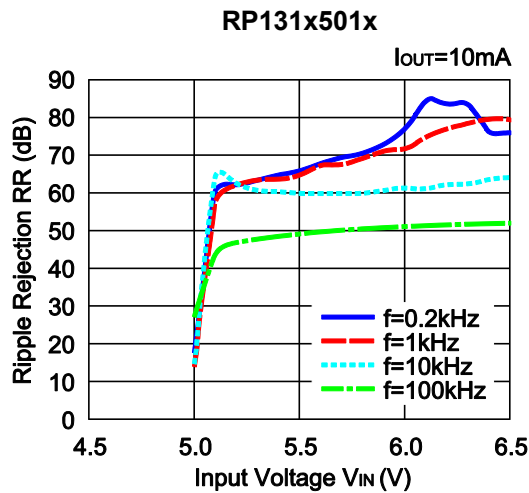


7) Dropout Voltage vs. Set Output Voltage

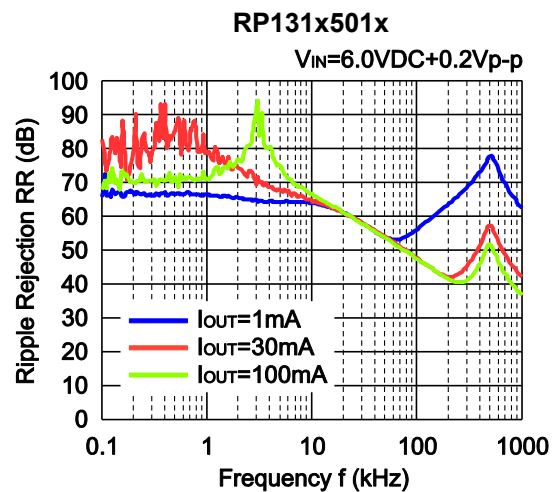
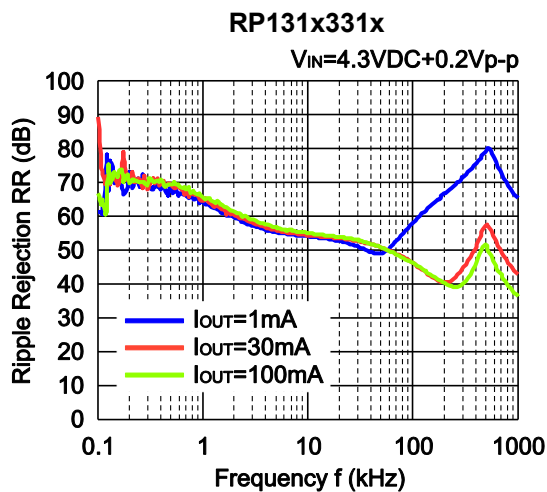
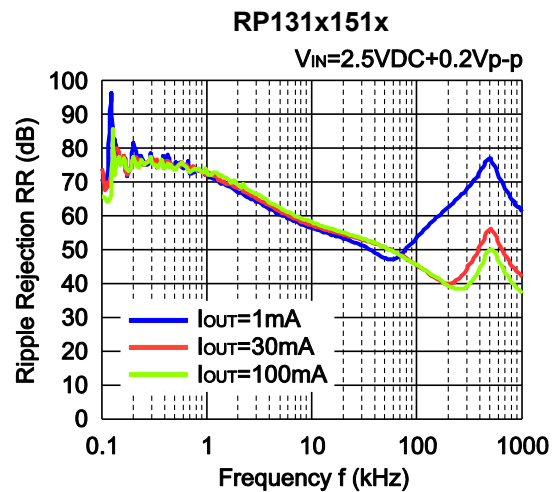
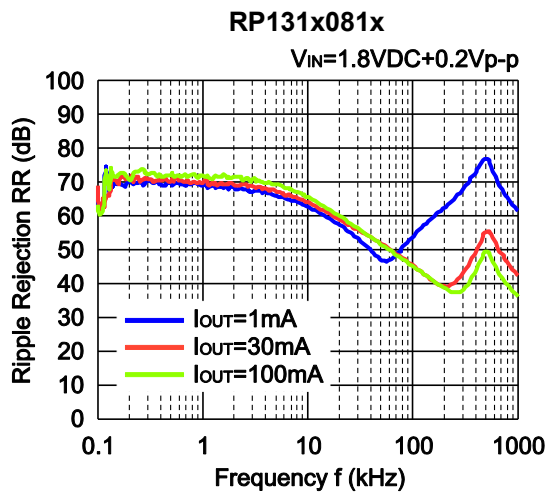


8) Ripple Rejection vs. Input Bias Voltage (C_{IN} =none, C_{OUT} =Ceramic $1.0\mu F$, Ripple=0.2Vp-p, $T_a=25^\circ C$)

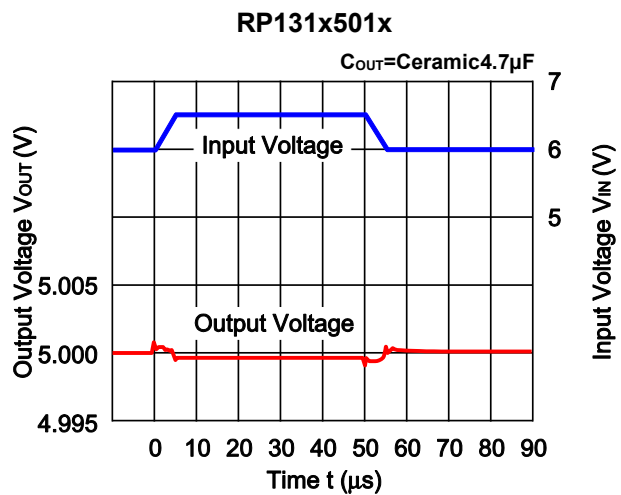
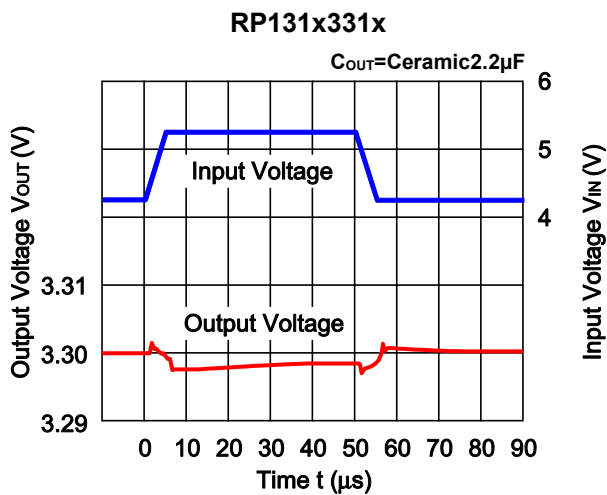
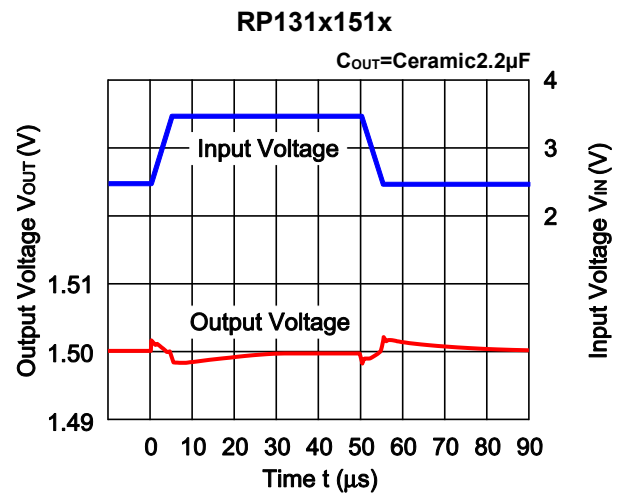
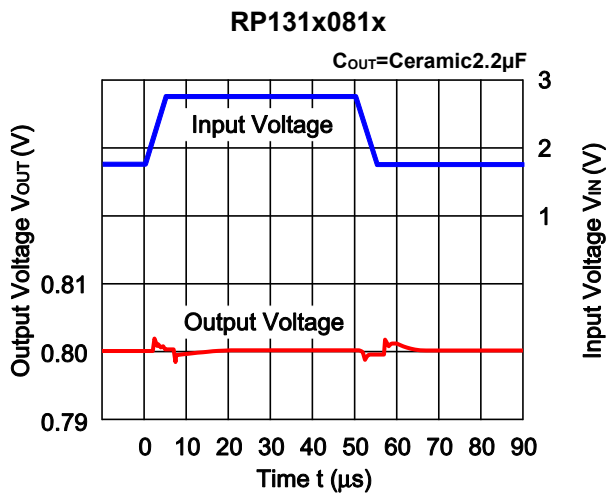




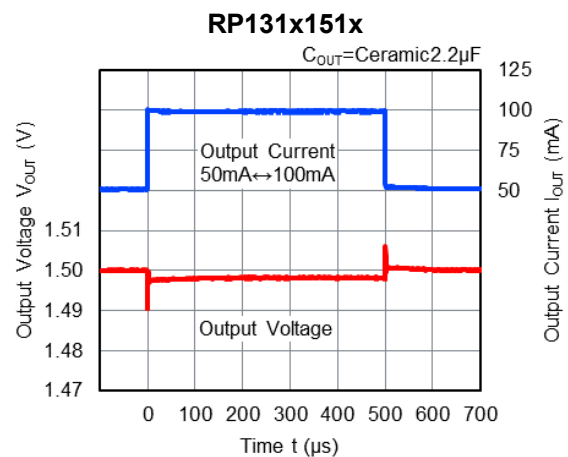
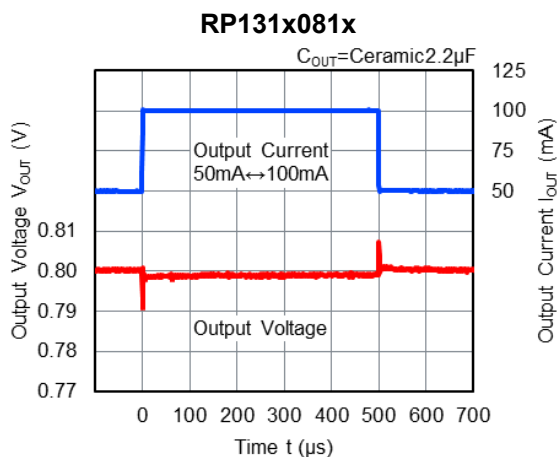
9) Ripple Rejection vs. Frequency (C_{IN} =none, C_{OUT} =Ceramic $4.7\mu F$, $T_a=25^{\circ}C$)

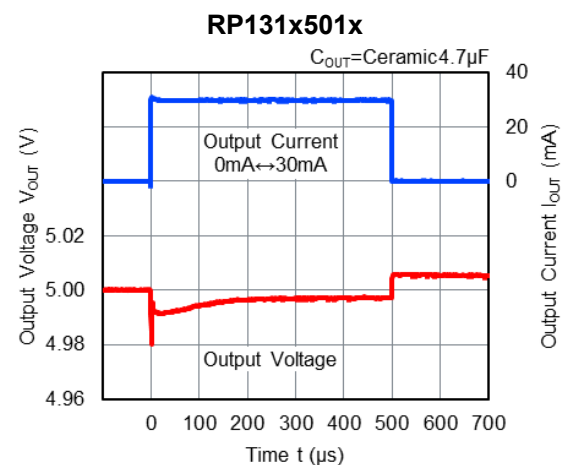
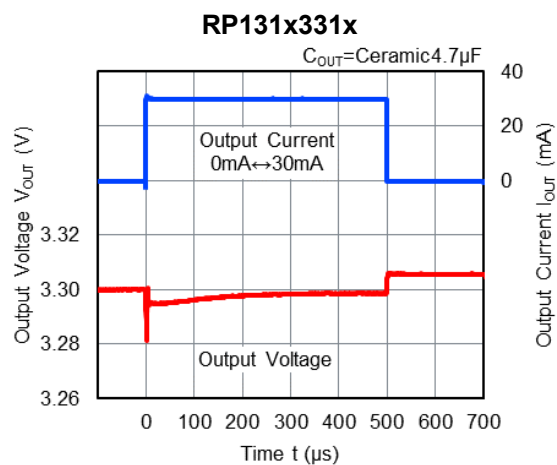
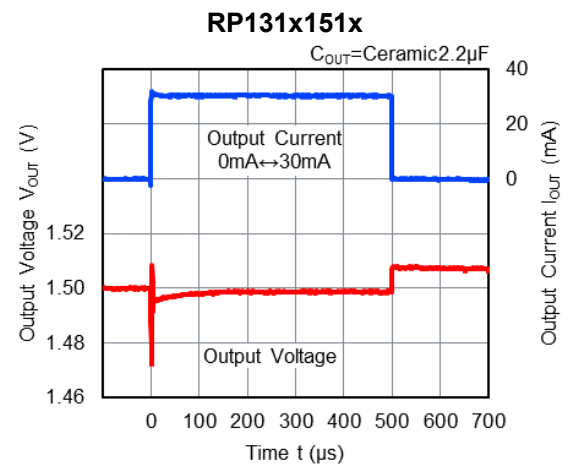
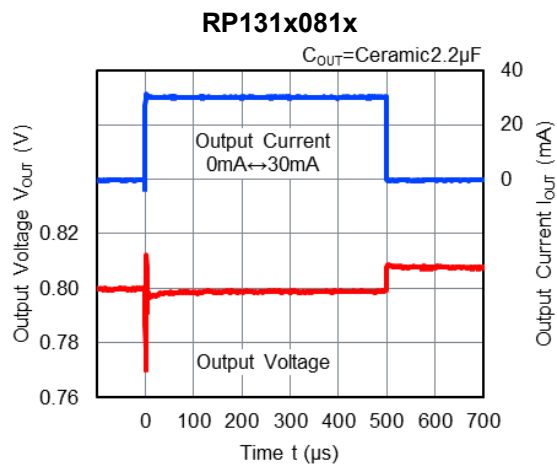
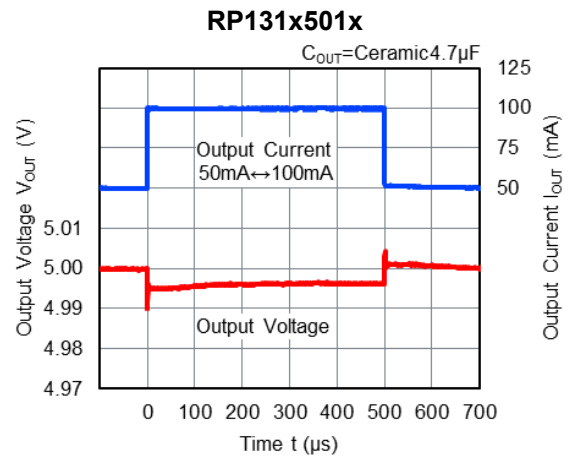
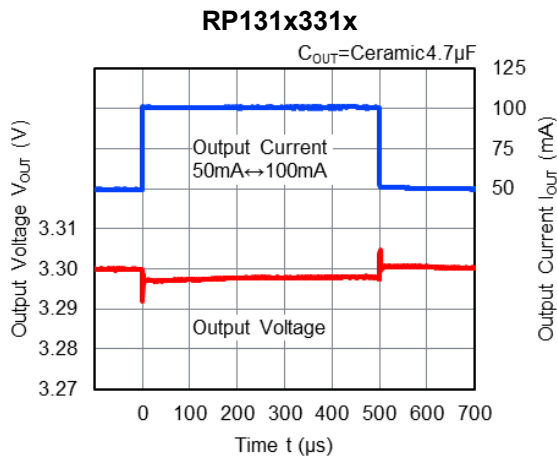


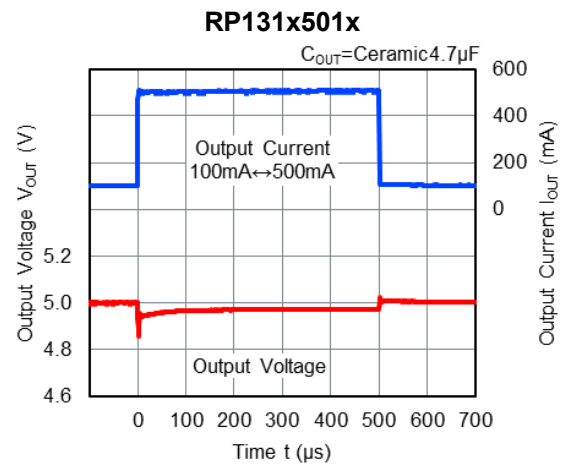
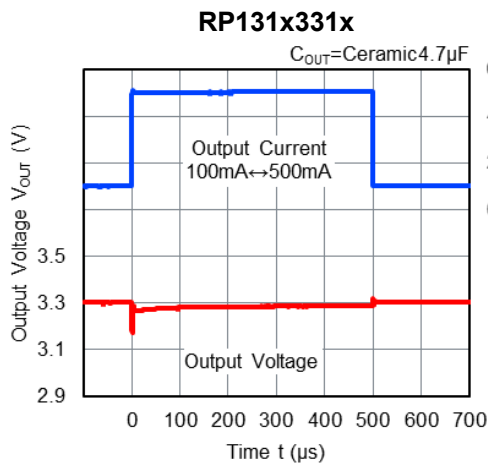
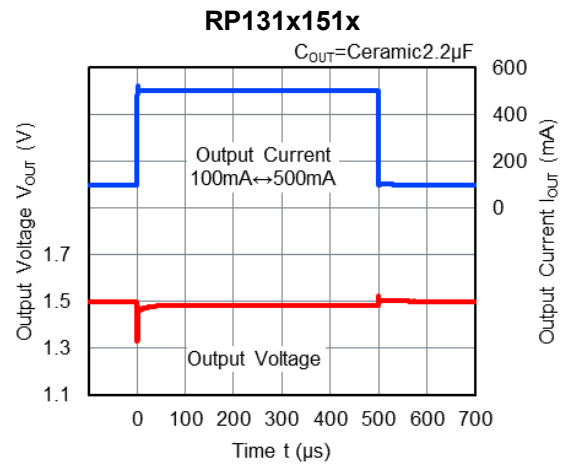
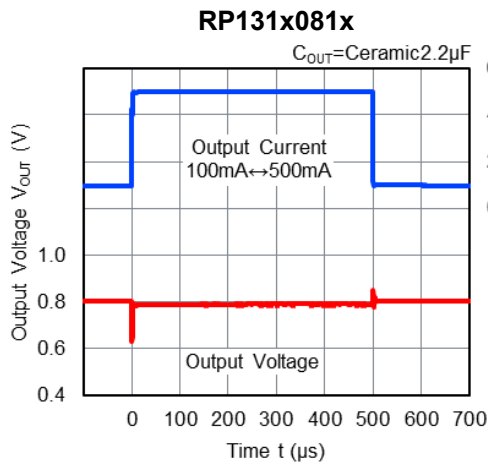
10) Input Transient Response ($I_{OUT}=100mA$, $t_r=t_f=5\mu s$, $C_{IN}=none$, $T_a=25^{\circ}C$)



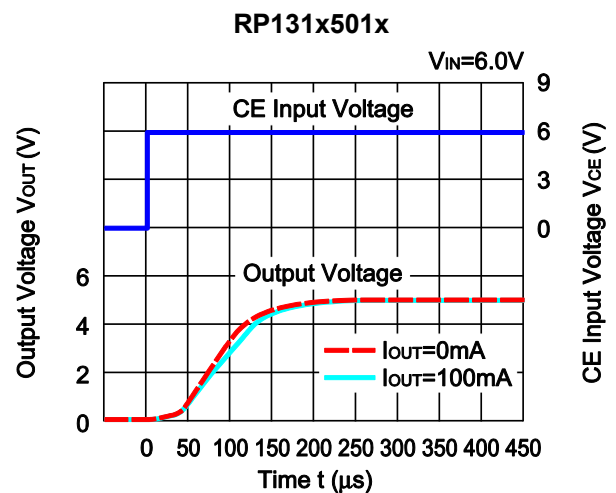
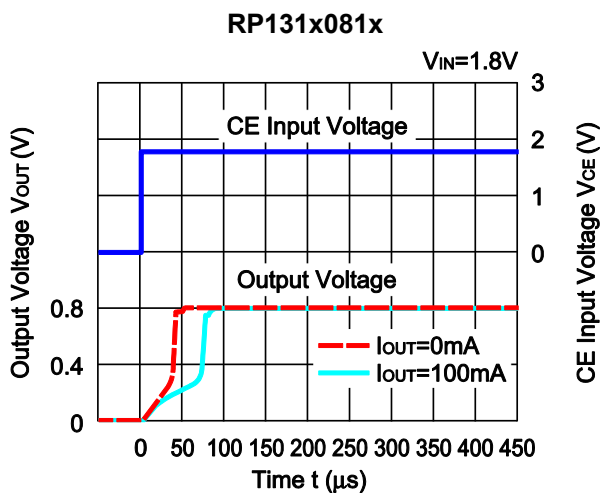
11) Load Transient Response ($t_r=t_f=0.5\mu s$, $C_{IN}=Ceramic2.2\mu F$, $V_{IN}=V_{OUT}+1.0V$, $T_a=25^{\circ}C$)



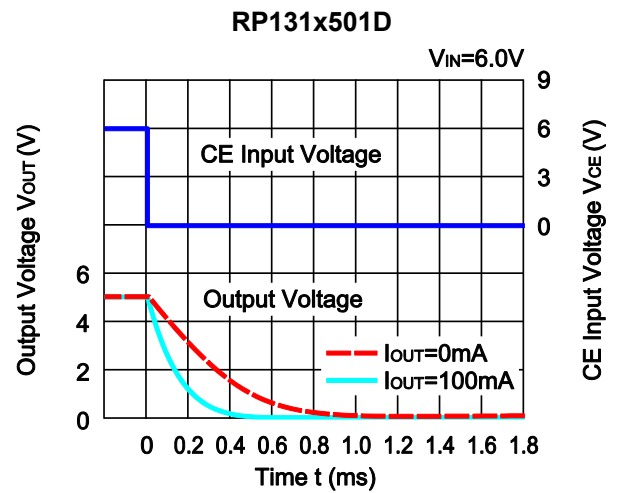
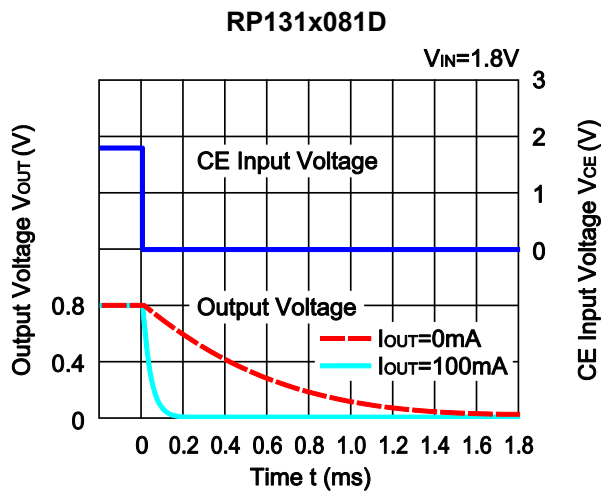




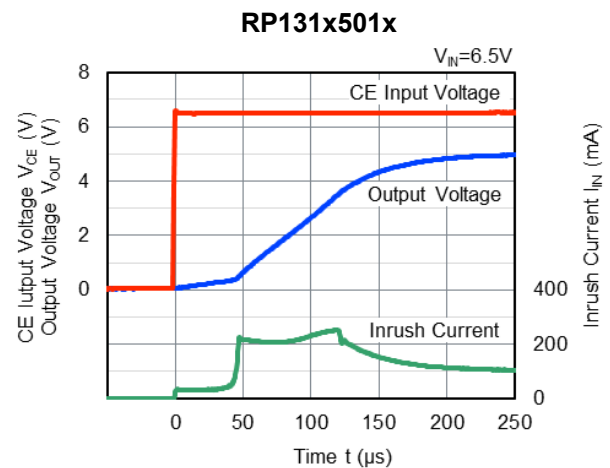
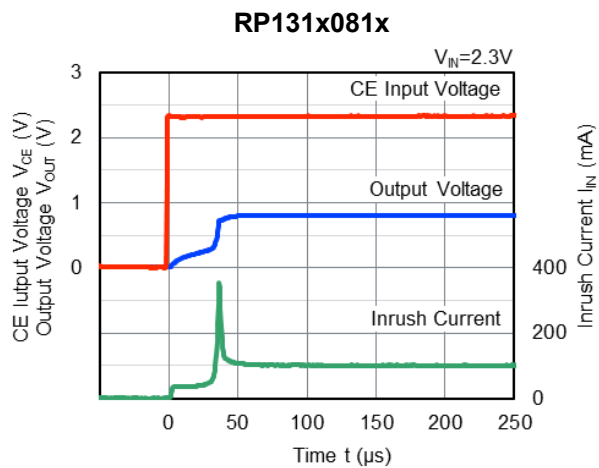
12) Turn On Speed with CE pin (C_{IN}=Ceramic 2.2μF, C_{OUT}=Ceramic 4.7μF, Ta=25°C)



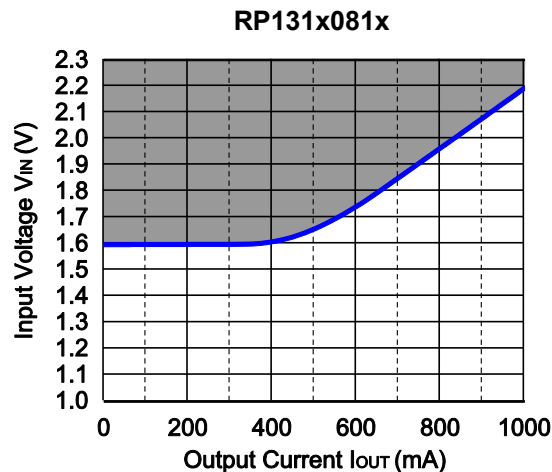
13) Turn Off Speed with CE pin (D Version) (C_{IN} =Ceramic 2.2 μ F, C_{OUT} =Ceramic 4.7 μ F, T_a =25°C)



14) Inrush Current at turning on (C_{IN} =Ceramic 2.2 μ F, C_{OUT} =Ceramic 4.7 μ F, T_a =25°C)



15) Minimum Operating Voltage



Hatched area is available for 0.8V output.

ESR vs. Output Current

When using these ICs, consider the following points:

The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below.

The conditions when the white noise level is under $40\mu V$ (Avg.) are marked as the hatched area in the graph.

Measurement conditions

Frequency Band : 10Hz to 3MHz

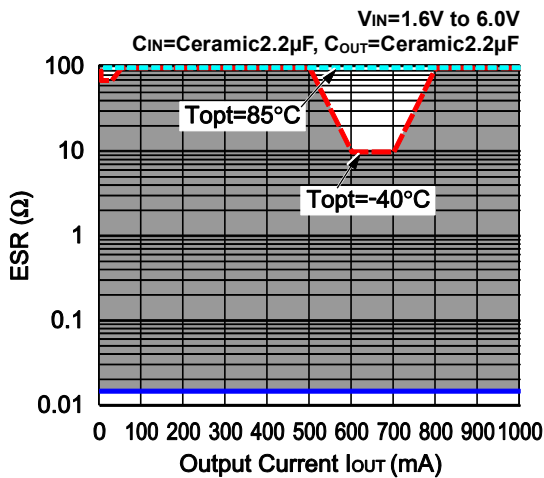
Temperature : $-40^{\circ}C$ to $85^{\circ}C$

C_{IN} : $2.2\mu F$ (Kyocera, CM05X5R225M04AD)

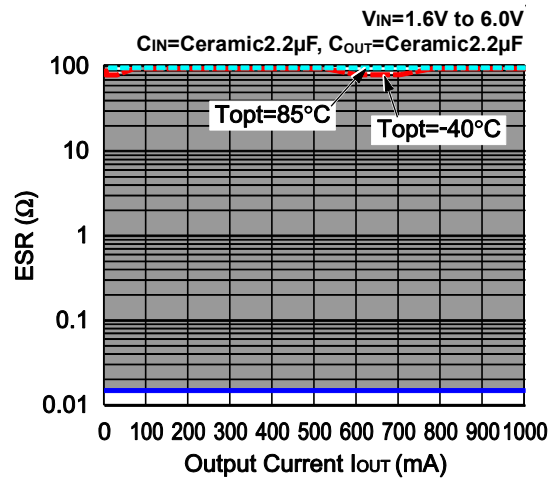
C_{OUT} : $2.2\mu F$ (Kyocera, CM105X5R225K06AE)

$4.7\mu F$ (Kyocera, CM105X5R475M06AB)

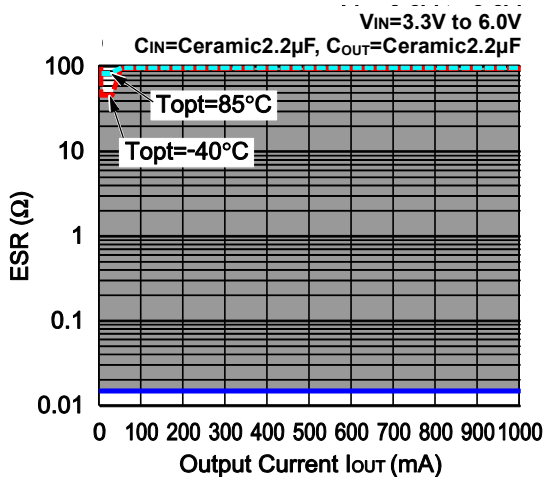
RP131x081x



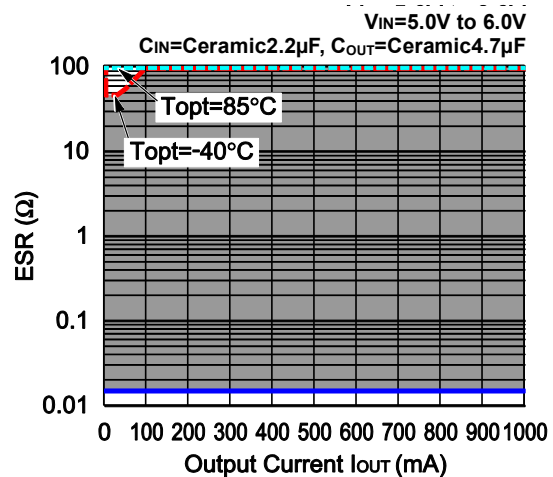
RP131x151x



RP131x331x



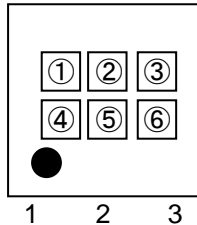
RP131x501x



RP131L SERIES MARK SPECIFICATION

• DFN1616-6B

6 5 4



① to ④ : Product Code (Refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

• Part Number vs. Product Code

RP131Lxx1B Series

Part Number	Product Code			
	①	②	③	④
RP131L081B	C	B	0	1
RP131L091B	C	B	0	2
RP131L101B	C	B	0	3
RP131L111B	C	B	0	4
RP131L121B	C	B	0	5
RP131L131B	C	B	0	7
RP131L141B	C	B	0	8
RP131L151B	C	B	0	9
RP131L161B	C	B	1	0
RP131L171B	C	B	1	1
RP131L181B	C	B	1	2
RP131L191B	C	B	1	4
RP131L201B	C	B	1	5
RP131L211B	C	B	1	6
RP131L221B	C	B	1	7
RP131L231B	C	B	1	8
RP131L241B	C	B	1	9
RP131L251B	C	B	2	0
RP131L261B	C	B	2	1
RP131L271B	C	B	2	2
RP131L281B	C	B	2	3
RP131L291B	C	B	2	5

RP131Lxx1D Series

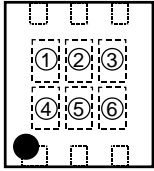
Part Number	Product Code			
	①	②	③	④
RP131L081D	C	C	0	1
RP131L091D	C	C	0	2
RP131L101D	C	C	0	3
RP131L111D	C	C	0	4
RP131L121D	C	C	0	5
RP131L131D	C	C	0	7
RP131L141D	C	C	0	8
RP131L151D	C	C	0	9
RP131L161D	C	C	1	0
RP131L171D	C	C	1	1
RP131L181D	C	C	1	2
RP131L191D	C	C	1	4
RP131L201D	C	C	1	5
RP131L211D	C	C	1	6
RP131L221D	C	C	1	7
RP131L231D	C	C	1	8
RP131L241D	C	C	1	9
RP131L251D	C	C	2	0
RP131L261D	C	C	2	1
RP131L271D	C	C	2	2
RP131L281D	C	C	2	3
RP131L291D	C	C	2	5

Part Number	Product Code			
	①	②	③	④
RP131L301B	C	B	2	6
RP131L311B	C	B	2	7
RP131L321B	C	B	2	8
RP131L331B	C	B	2	9
RP131L341B	C	B	3	0
RP131L351B	C	B	3	1
RP131L361B	C	B	3	2
RP131L371B	C	B	3	3
RP131L381B	C	B	3	4
RP131L391B	C	B	3	5
RP131L401B	C	B	3	6
RP131L411B	C	B	3	7
RP131L421B	C	B	3	8
RP131L431B	C	B	3	9
RP131L441B	C	B	4	0
RP131L451B	C	B	4	1
RP131L461B	C	B	4	2
RP131L471B	C	B	4	3
RP131L481B	C	B	4	4
RP131L491B	C	B	4	5
RP131L501B	C	B	4	6
RP131L511B	C	B	4	8
RP131L521B	C	B	4	9
RP131L531B	C	B	5	0
RP131L541B	C	B	5	1
RP131L551B	C	B	5	2
RP131L101B5	C	B	4	7
RP131L121B5	C	B	0	6
RP131L181B5	C	B	1	3
RP131L281B5	C	B	2	4

Part Number	Product Code			
	①	②	③	④
RP131L301D	C	C	2	6
RP131L311D	C	C	2	7
RP131L321D	C	C	2	8
RP131L331D	C	C	2	9
RP131L341D	C	C	3	0
RP131L351D	C	C	3	1
RP131L361D	C	C	3	2
RP131L371D	C	C	3	3
RP131L381D	C	C	3	4
RP131L391D	C	C	3	5
RP131L401D	C	C	3	6
RP131L411D	C	C	3	7
RP131L421D	C	C	3	8
RP131L431D	C	C	3	9
RP131L441D	C	C	4	0
RP131L451D	C	C	4	1
RP131L461D	C	C	4	2
RP131L471D	C	C	4	3
RP131L481D	C	C	4	4
RP131L491D	C	C	4	5
RP131L501D	C	C	4	6
RP131L511D	C	C	4	8
RP131L521D	C	C	4	9
RP131L531D	C	C	5	0
RP131L541D	C	C	5	1
RP131L551D	C	C	5	2
RP131L101D5	C	C	4	7
RP131L121D5	C	C	0	6
RP131L181D5	C	C	1	3
RP131L281D5	C	C	2	4

RP131K SERIES MARK SPECIFICATION

• DFN(PL)1820-6



① to ④ : Product Code (Refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

• Part Number vs. Product Code

RP131Kxx1B Series

Part Number	Product Code			
	①	②	③	④
RP131K081B	A	M	0	1
RP131K091B	A	M	0	2
RP131K101B	A	M	0	3
RP131K111B	A	M	0	4
RP131K121B	A	M	0	5
RP131K131B	A	M	0	7
RP131K141B	A	M	0	8
RP131K151B	A	M	0	9
RP131K161B	A	M	1	0
RP131K171B	A	M	1	1
RP131K181B	A	M	1	2
RP131K191B	A	M	1	4
RP131K201B	A	M	1	5
RP131K211B	A	M	1	6
RP131K221B	A	M	1	7
RP131K231B	A	M	1	8
RP131K241B	A	M	1	9
RP131K251B	A	M	2	0
RP131K261B	A	M	2	1
RP131K271B	A	M	2	2
RP131K281B	A	M	2	3
RP131K291B	A	M	2	5

Part Number	Product Code			
	①	②	③	④
RP131K301B	A	M	2	6
RP131K311B	A	M	2	7
RP131K321B	A	M	2	8
RP131K331B	A	M	2	9
RP131K341B	A	M	3	0
RP131K351B	A	M	3	1
RP131K361B	A	M	3	2
RP131K371B	A	M	3	3
RP131K381B	A	M	3	4
RP131K391B	A	M	3	5
RP131K401B	A	M	3	6
RP131K411B	A	M	3	7
RP131K421B	A	M	3	8
RP131K431B	A	M	3	9
RP131K441B	A	M	4	0
RP131K451B	A	M	4	1
RP131K461B	A	M	4	2
RP131K471B	A	M	4	3
RP131K481B	A	M	4	4
RP131K491B	A	M	4	5
RP131K501B	A	M	4	6
RP131K511B	A	M	4	9
RP131K521B	A	M	5	0
RP131K531B	A	M	5	1
RP131K541B	A	M	5	2
RP131K551B	A	M	4	8
RP131K101B5	A	M	4	7
RP131K121B5	A	M	0	6
RP131K181B5	A	M	1	3
RP131K281B5	A	M	2	4

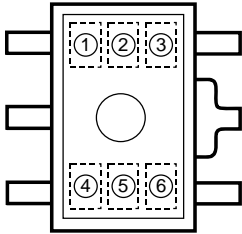
RP131Kxx1D Series

Part Number	Product Code			
	①	②	③	④
RP131K081D	A	N	0	1
RP131K091D	A	N	0	2
RP131K101D	A	N	0	3
RP131K111D	A	N	0	4
RP131K121D	A	N	0	5
RP131K131D	A	N	0	7
RP131K141D	A	N	0	8
RP131K151D	A	N	0	9
RP131K161D	A	N	1	0
RP131K171D	A	N	1	1
RP131K181D	A	N	1	2
RP131K191D	A	N	1	4
RP131K201D	A	N	1	5
RP131K211D	A	N	1	6
RP131K221D	A	N	1	7
RP131K231D	A	N	1	8
RP131K241D	A	N	1	9
RP131K251D	A	N	2	0
RP131K261D	A	N	2	1
RP131K271D	A	N	2	2
RP131K281D	A	N	2	3
RP131K291D	A	N	2	5

Part Number	Product Code			
	①	②	③	④
RP131K301D	A	N	2	6
RP131K311D	A	N	2	7
RP131K321D	A	N	2	8
RP131K331D	A	N	2	9
RP131K341D	A	N	3	0
RP131K351D	A	N	3	1
RP131K361D	A	N	3	2
RP131K371D	A	N	3	3
RP131K381D	A	N	3	4
RP131K391D	A	N	3	5
RP131K401D	A	N	3	6
RP131K411D	A	N	3	7
RP131K421D	A	N	3	8
RP131K431D	A	N	3	9
RP131K441D	A	N	4	0
RP131K451D	A	N	4	1
RP131K461D	A	N	4	2
RP131K471D	A	N	4	3
RP131K481D	A	N	4	4
RP131K491D	A	N	4	5
RP131K501D	A	N	4	6
RP131K511D	A	N	4	9
RP131K521D	A	N	5	0
RP131K531D	A	N	5	1
RP131K541D	A	N	5	2
RP131K551D	A	N	4	8
RP131K101D5	A	N	4	7
RP131K121D5	A	N	0	6
RP131K181D5	A	N	1	3
RP131K281D5	A	N	2	4

RP131H SERIES MARK SPECIFICATION

● SOT-89-5



① to ④ : Product Code (Refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

● Part Number vs. Product Code

RP131Hxx1B Series

Part Number	Product Code			
	①	②	③	④
RP131H081B	U	0	8	B
RP131H091B	U	0	9	B
RP131H101B	U	1	0	B
RP131H111B	U	1	1	B
RP131H121B	U	1	2	B
RP131H131B	U	1	3	B
RP131H141B	U	1	4	B
RP131H151B	U	1	5	B
RP131H161B	U	1	6	B
RP131H171B	U	1	7	B
RP131H181B	U	1	8	B
RP131H191B	U	1	9	B
RP131H201B	U	2	0	B
RP131H211B	U	2	1	B
RP131H221B	U	2	2	B
RP131H231B	U	2	3	B
RP131H241B	U	2	4	B
RP131H251B	U	2	5	B
RP131H261B	U	2	6	B
RP131H271B	U	2	7	B
RP131H281B	U	2	8	B
RP131H291B	U	2	9	B
RP131H301B	U	3	0	B
RP131H311B	U	3	1	B
RP131H321B	U	3	2	B
RP131H331B	U	3	3	B
RP131H341B	U	3	4	B
RP131H351B	U	3	5	B
RP131H361B	U	3	6	B
RP131H371B	U	3	7	B
RP131H381B	U	3	8	B
RP131H391B	U	3	9	B

Part Number	Product Code			
	①	②	③	④
RP131H401B	U	4	0	B
RP131H411B	U	4	1	B
RP131H421B	U	4	2	B
RP131H431B	U	4	3	B
RP131H441B	U	4	4	B
RP131H451B	U	4	5	B
RP131H461B	U	4	6	B
RP131H471B	U	4	7	B
RP131H481B	U	4	8	B
RP131H491B	U	4	9	B
RP131H501B	U	5	0	B
RP131H511B	U	5	1	B
RP131H521B	U	5	2	B
RP131H531B	U	5	3	B
RP131H541B	U	5	4	B
RP131H551B	U	5	5	B
RP131H101B5	U	0	4	B
RP131H121B5	U	0	1	B
RP131H181B5	U	0	2	B
RP131H281B5	U	0	3	B

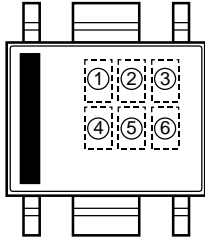
RP131Hxx1D Series

Part Number	Product Code			
	①	②	③	④
RP131H081D	U	0	8	D
RP131H091D	U	0	9	D
RP131H101D	U	1	0	D
RP131H111D	U	1	1	D
RP131H121D	U	1	2	D
RP131H131D	U	1	3	D
RP131H141D	U	1	4	D
RP131H151D	U	1	5	D
RP131H161D	U	1	6	D
RP131H171D	U	1	7	D
RP131H181D	U	1	8	D
RP131H191D	U	1	9	D
RP131H201D	U	2	0	D
RP131H211D	U	2	1	D
RP131H221D	U	2	2	D
RP131H231D	U	2	3	D
RP131H241D	U	2	4	D
RP131H251D	U	2	5	D
RP131H261D	U	2	6	D
RP131H271D	U	2	7	D
RP131H281D	U	2	8	D
RP131H291D	U	2	9	D
RP131H301D	U	3	0	D
RP131H311D	U	3	1	D
RP131H321D	U	3	2	D
RP131H331D	U	3	3	D
RP131H341D	U	3	4	D
RP131H351D	U	3	5	D
RP131H361D	U	3	6	D
RP131H371D	U	3	7	D
RP131H381D	U	3	8	D
RP131H391D	U	3	9	D

Part Number	Product Code			
	①	②	③	④
RP131H401D	U	4	0	D
RP131H411D	U	4	1	D
RP131H421D	U	4	2	D
RP131H431D	U	4	3	D
RP131H441D	U	4	4	D
RP131H451D	U	4	5	D
RP131H461D	U	4	6	D
RP131H471D	U	4	7	D
RP131H481D	U	4	8	D
RP131H491D	U	4	9	D
RP131H501D	U	5	0	D
RP131H511D	U	5	1	D
RP131H521D	U	5	2	D
RP131H531D	U	5	3	D
RP131H541D	U	5	4	D
RP131H551D	U	5	5	D
RP131H101D5	U	0	4	D
RP131H121D5	U	0	1	D
RP131H181D5	U	0	2	D
RP131H281D5	U	0	3	D

RP131S SERIES MARK SPECIFICATION

● HSOP-6J



① to ④ : Product Code (Refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

● Part Number vs. Product Code

RP131Sxx1B Series

Part Number	Product Code			
	①	②	③	④
RP131S081B	G	0	8	B
RP131S091B	G	0	9	B
RP131S101B	G	1	0	B
RP131S111B	G	1	1	B
RP131S121B	G	1	2	B
RP131S131B	G	1	3	B
RP131S141B	G	1	4	B
RP131S151B	G	1	5	B
RP131S161B	G	1	6	B
RP131S171B	G	1	7	B
RP131S181B	G	1	8	B
RP131S191B	G	1	9	B
RP131S201B	G	2	0	B
RP131S211B	G	2	1	B
RP131S221B	G	2	2	B
RP131S231B	G	2	3	B
RP131S241B	G	2	4	B
RP131S251B	G	2	5	B
RP131S261B	G	2	6	B
RP131S271B	G	2	7	B
RP131S281B	G	2	8	B
RP131S291B	G	2	9	B
RP131S301B	G	3	0	B
RP131S311B	G	3	1	B
RP131S321B	G	3	2	B
RP131S331B	G	3	3	B
RP131S341B	G	3	4	B
RP131S351B	G	3	5	B
RP131S361B	G	3	6	B
RP131S371B	G	3	7	B
RP131S381B	G	3	8	B
RP131S391B	G	3	9	B

Part Number	Product Code			
	①	②	③	④
RP131S401B	G	4	0	B
RP131S411B	G	4	1	B
RP131S421B	G	4	2	B
RP131S431B	G	4	3	B
RP131S441B	G	4	4	B
RP131S451B	G	4	5	B
RP131S461B	G	4	6	B
RP131S471B	G	4	7	B
RP131S481B	G	4	8	B
RP131S491B	G	4	9	B
RP131S501B	G	5	0	B
RP131S511B	G	5	1	B
RP131S521B	G	5	2	B
RP131S531B	G	5	3	B
RP131S541B	G	5	4	B
RP131S551B	G	5	5	B
RP131S101B5	G	0	4	B
RP131S121B5	G	0	1	B
RP131S181B5	G	0	2	B
RP131S281B5	G	0	3	B

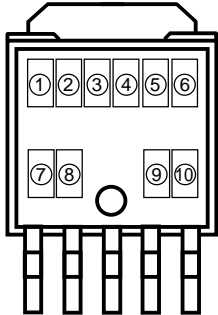
RP131Sxx1D Series

Part Number	Product Code			
	①	②	③	④
RP131S081D	G	0	8	D
RP131S091D	G	0	9	D
RP131S101D	G	1	0	D
RP131S111D	G	1	1	D
RP131S121D	G	1	2	D
RP131S131D	G	1	3	D
RP131S141D	G	1	4	D
RP131S151D	G	1	5	D
RP131S161D	G	1	6	D
RP131S171D	G	1	7	D
RP131S181D	G	1	8	D
RP131S191D	G	1	9	D
RP131S201D	G	2	0	D
RP131S211D	G	2	1	D
RP131S221D	G	2	2	D
RP131S231D	G	2	3	D
RP131S241D	G	2	4	D
RP131S251D	G	2	5	D
RP131S261D	G	2	6	D
RP131S271D	G	2	7	D
RP131S281D	G	2	8	D
RP131S291D	G	2	9	D
RP131S301D	G	3	0	D
RP131S311D	G	3	1	D
RP131S321D	G	3	2	D
RP131S331D	G	3	3	D
RP131S341D	G	3	4	D
RP131S351D	G	3	5	D
RP131S361D	G	3	6	D
RP131S371D	G	3	7	D
RP131S381D	G	3	8	D
RP131S391D	G	3	9	D

Part Number	Product Code			
	①	②	③	④
RP131S401D	G	4	0	D
RP131S411D	G	4	1	D
RP131S421D	G	4	2	D
RP131S431D	G	4	3	D
RP131S441D	G	4	4	D
RP131S451D	G	4	5	D
RP131S461D	G	4	6	D
RP131S471D	G	4	7	D
RP131S481D	G	4	8	D
RP131S491D	G	4	9	D
RP131S501D	G	5	0	D
RP131S511D	G	5	1	D
RP131S521D	G	5	2	D
RP131S531D	G	5	3	D
RP131S541D	G	5	4	D
RP131S551D	G	5	5	D
RP131S101D5	G	0	4	D
RP131S121D5	G	0	1	D
RP131S181D5	G	0	2	D
RP131S281D5	G	0	3	D

RP131J SERIES MARK SPECIFICATION

● TO-252-5-P2



① to ⑧ : Product Code (Refer to Part Number vs. Product Code)

⑨, ⑩ : Lot Number

● Part Number vs. Product Code

RP131Jxx1B Series

Part Number	Product Code							
	①	②	③	④	⑤	⑥	⑦	⑧
RP131J081B	D	1	J	0	8	1	B	
RP131J091B	D	1	J	0	9	1	B	
RP131J101B	D	1	J	1	0	1	B	
RP131J111B	D	1	J	1	1	1	B	
RP131J121B	D	1	J	1	2	1	B	
RP131J131B	D	1	J	1	3	1	B	
RP131J141B	D	1	J	1	4	1	B	
RP131J151B	D	1	J	1	5	1	B	
RP131J161B	D	1	J	1	6	1	B	
RP131J171B	D	1	J	1	7	1	B	
RP131J181B	D	1	J	1	8	1	B	
RP131J191B	D	1	J	1	9	1	B	
RP131J201B	D	1	J	2	0	1	B	
RP131J211B	D	1	J	2	1	1	B	
RP131J221B	D	1	J	2	2	1	B	
RP131J231B	D	1	J	2	3	1	B	
RP131J241B	D	1	J	2	4	1	B	
RP131J251B	D	1	J	2	5	1	B	
RP131J261B	D	1	J	2	6	1	B	
RP131J271B	D	1	J	2	7	1	B	
RP131J281B	D	1	J	2	8	1	B	
RP131J291B	D	1	J	2	9	1	B	
RP131J301B	D	1	J	3	0	1	B	
RP131J311B	D	1	J	3	1	1	B	
RP131J321B	D	1	J	3	2	1	B	
RP131J331B	D	1	J	3	3	1	B	
RP131J341B	D	1	J	3	4	1	B	
RP131J351B	D	1	J	3	5	1	B	
RP131J361B	D	1	J	3	6	1	B	
RP131J371B	D	1	J	3	7	1	B	
RP131J381B	D	1	J	3	8	1	B	
RP131J391B	D	1	J	3	9	1	B	
RP131J401B	D	1	J	4	0	1	B	
RP131J411B	D	1	J	4	1	1	B	
RP131J421B	D	1	J	4	2	1	B	
RP131J431B	D	1	J	4	3	1	B	
RP131J441B	D	1	J	4	4	1	B	
RP131J451B	D	1	J	4	5	1	B	
RP131J461B	D	1	J	4	6	1	B	

Part Number	Product Code							
	①	②	③	④	⑤	⑥	⑦	⑧
RP131J471B	D	1	J	4	7	1	B	
RP131J481B	D	1	J	4	8	1	B	
RP131J491B	D	1	J	4	9	1	B	
RP131J501B	D	1	J	5	0	1	B	
RP131J511B	D	1	J	5	1	1	B	
RP131J521B	D	1	J	5	2	1	B	
RP131J531B	D	1	J	5	3	1	B	
RP131J541B	D	1	J	5	4	1	B	
RP131J551B	D	1	J	5	5	1	B	
RP131J101B5	D	1	J	1	0	1	B	5
RP131J121B5	D	1	J	1	2	1	B	5
RP131J181B5	D	1	J	1	8	1	B	5
RP131J281B5	D	1	J	2	8	1	B	5

RP131Jxx1D Series

Part Number	Product Code							
	①	②	③	④	⑤	⑥	⑦	⑧
RP131J081D	D	1	J	0	8	1	D	
RP131J091D	D	1	J	0	9	1	D	
RP131J101D	D	1	J	1	0	1	D	
RP131J111D	D	1	J	1	1	1	D	
RP131J121D	D	1	J	1	2	1	D	
RP131J131D	D	1	J	1	3	1	D	
RP131J141D	D	1	J	1	4	1	D	
RP131J151D	D	1	J	1	5	1	D	
RP131J161D	D	1	J	1	6	1	D	
RP131J171D	D	1	J	1	7	1	D	
RP131J181D	D	1	J	1	8	1	D	
RP131J191D	D	1	J	1	9	1	D	
RP131J201D	D	1	J	2	0	1	D	
RP131J211D	D	1	J	2	1	1	D	
RP131J221D	D	1	J	2	2	1	D	
RP131J231D	D	1	J	2	3	1	D	
RP131J241D	D	1	J	2	4	1	D	
RP131J251D	D	1	J	2	5	1	D	
RP131J261D	D	1	J	2	6	1	D	
RP131J271D	D	1	J	2	7	1	D	
RP131J281D	D	1	J	2	8	1	D	
RP131J291D	D	1	J	2	9	1	D	

Part Number	Product Code							
	①	②	③	④	⑤	⑥	⑦	⑧
RP131J301D	D	1	J	3	0	1	D	
RP131J311D	D	1	J	3	1	1	D	
RP131J321D	D	1	J	3	2	1	D	
RP131J331D	D	1	J	3	3	1	D	
RP131J341D	D	1	J	3	4	1	D	
RP131J351D	D	1	J	3	5	1	D	
RP131J361D	D	1	J	3	6	1	D	
RP131J371D	D	1	J	3	7	1	D	
RP131J381D	D	1	J	3	8	1	D	
RP131J391D	D	1	J	3	9	1	D	
RP131J401D	D	1	J	4	0	1	D	
RP131J411D	D	1	J	4	1	1	D	
RP131J421D	D	1	J	4	2	1	D	
RP131J431D	D	1	J	4	3	1	D	
RP131J441D	D	1	J	4	4	1	D	
RP131J451D	D	1	J	4	5	1	D	
RP131J461D	D	1	J	4	6	1	D	
RP131J471D	D	1	J	4	7	1	D	
RP131J481D	D	1	J	4	8	1	D	
RP131J491D	D	1	J	4	9	1	D	
RP131J501D	D	1	J	5	0	1	D	
RP131J511D	D	1	J	5	1	1	D	
RP131J521D	D	1	J	5	2	1	D	
RP131J531D	D	1	J	5	3	1	D	
RP131J541D	D	1	J	5	4	1	D	
RP131J551D	D	1	J	5	5	1	D	
RP131J101D5	D	1	J	1	0	1	D	5
RP131J121D5	D	1	J	1	2	1	D	5
RP131J181D5	D	1	J	1	8	1	D	5
RP131J281D5	D	1	J	2	8	1	D	5

POWER DISSIPATION

DFN1616-6B

PD-DFN1616-6B-(85125150)-JE-B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.2 mm × 25 pcs

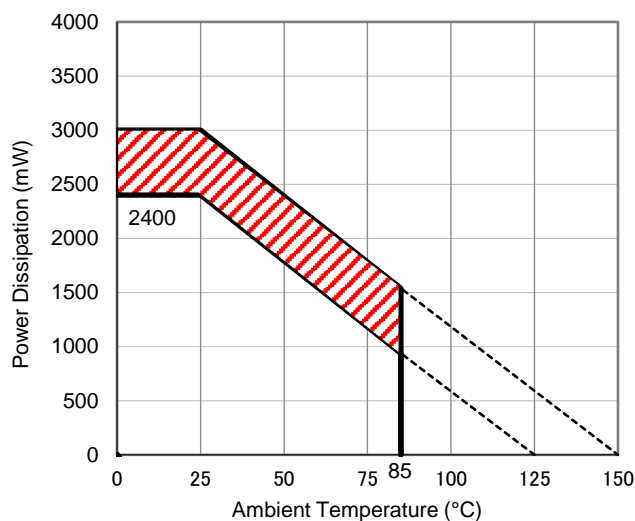
Measurement Result

(Ta = 25°C, Tjmax = 125°C)

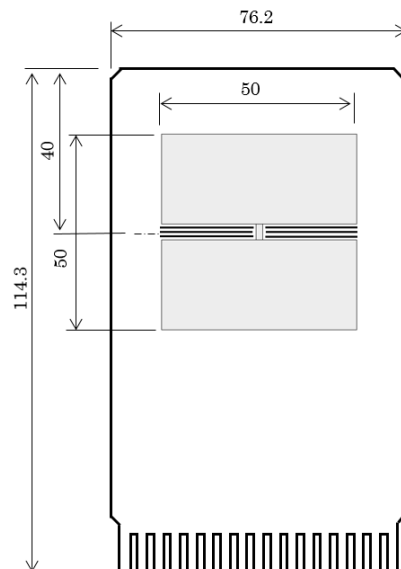
Item	Measurement Result
Power Dissipation	2400 mW
Thermal Resistance (θja)	θja = 41°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 11°C/W

θja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

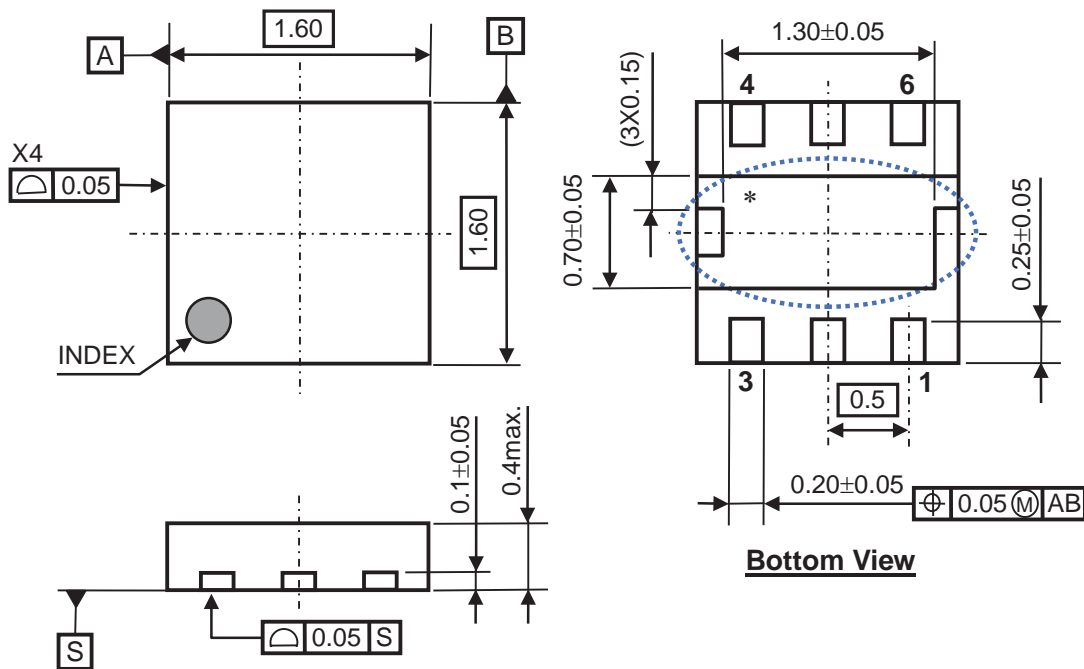
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

PACKAGE DIMENSIONS

DFN1616-6B

Ver. A



DFN1616-6B Package Dimensions (Unit: mm)

* The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane pin on the board but it is possible to leave the tab floating.

POWER DISSIPATION

DFN(PL)1820-6

PD-DFN(PL)1820-6-(85125150)-JE-B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.2 mm × 36 pcs

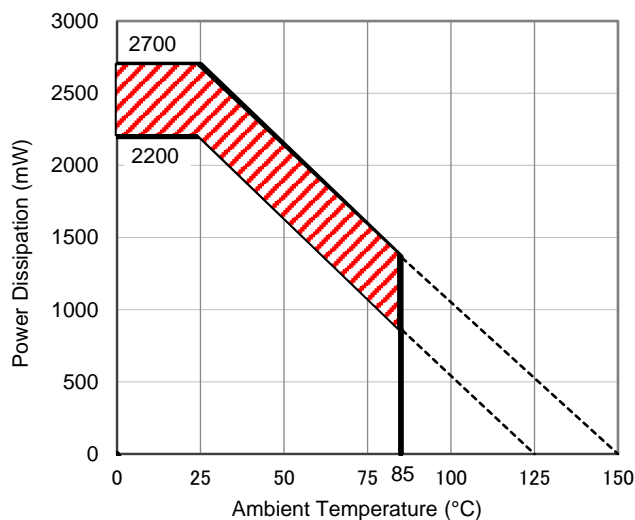
Measurement Result

(Ta = 25°C, Tjmax = 125°C)

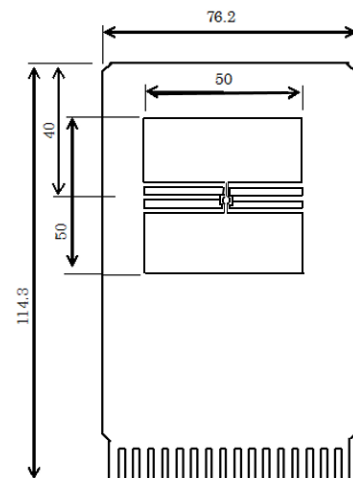
Item	Measurement Result
Power Dissipation	2200 mW
Thermal Resistance (θja)	θja = 45°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 18°C/W

θja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

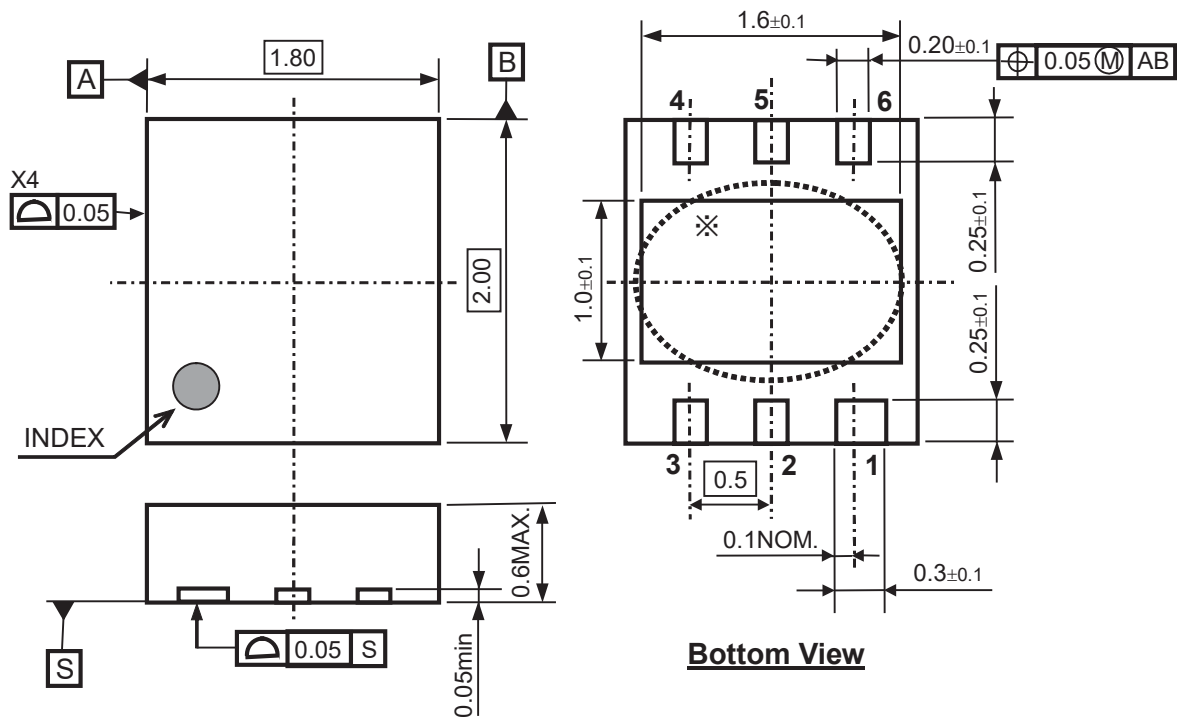
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

PACKAGE DIMENSIONS

DFN(PL)1820-6

Ver. A



DFN(PL)1820-6 Package Dimensions (Unit: mm)

* The tab on the bottom of the package is substrate level (GND). It is recommended that the tab be connected to the ground plane on the board, or otherwise be left floating.

POWER DISSIPATION

SOT-89-5

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 13 pcs

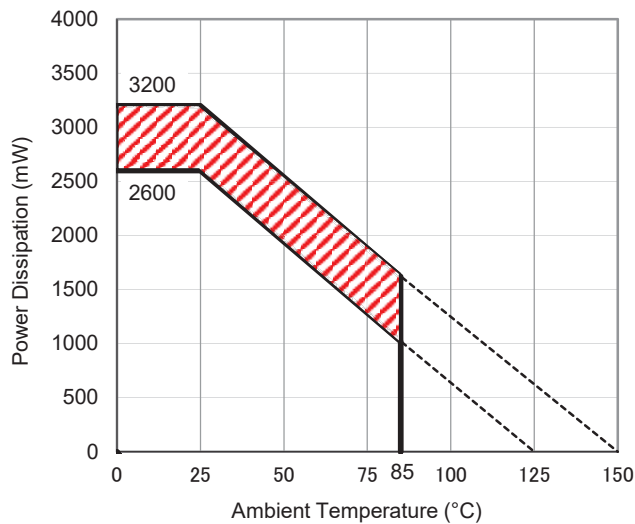
Measurement Result

(Ta = 25°C, Tjmax = 125°C)

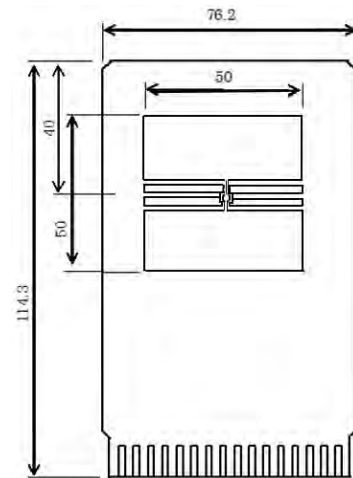
Item	Measurement Result
Power Dissipation	2600 mW
Thermal Resistance (θja)	θja = 38°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 13°C/W

θja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

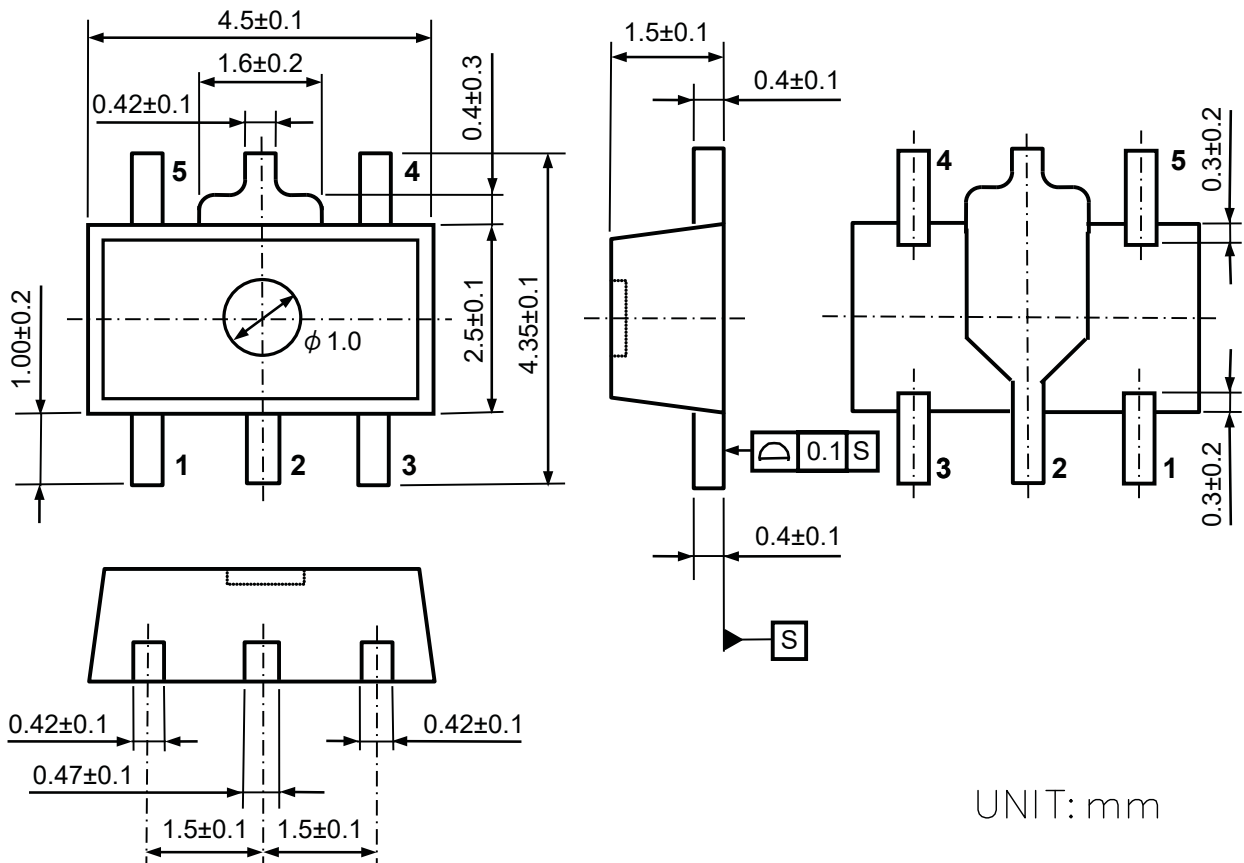
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

PACKAGE DIMENSIONS

SOT-89-5

Ver. A



SOT-89-5 Package Dimensions

POWER DISSIPATION

HSOP-6J

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 28 pcs

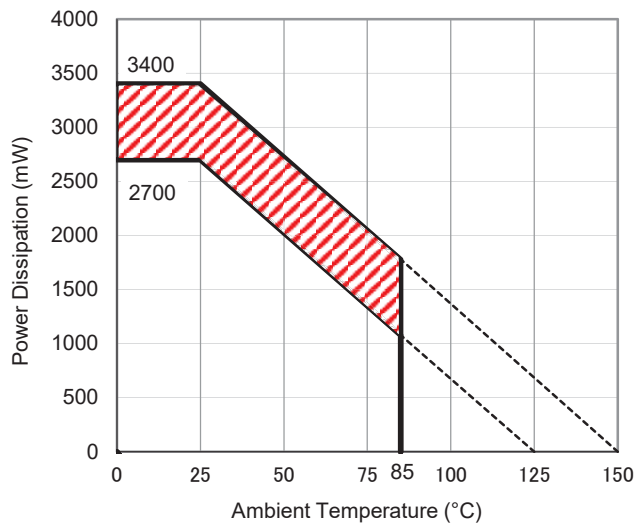
Measurement Result

(Ta = 25°C, Tjmax = 125°C)

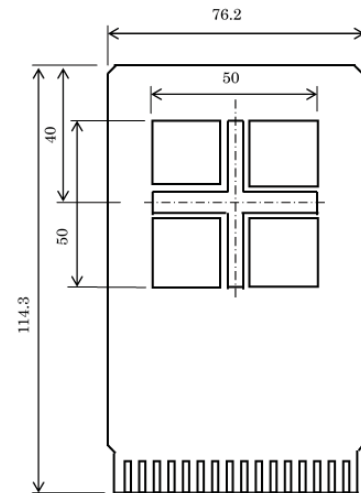
Item	Measurement Result
Power Dissipation	2700 mW
Thermal Resistance (θ_{ja})	$\theta_{ja} = 37^{\circ}\text{C/W}$
Thermal Characterization Parameter (ψ_{jt})	$\psi_{jt} = 7^{\circ}\text{C/W}$

θ_{ja} : Junction-to-Ambient Thermal Resistance

ψ_{jt} : Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

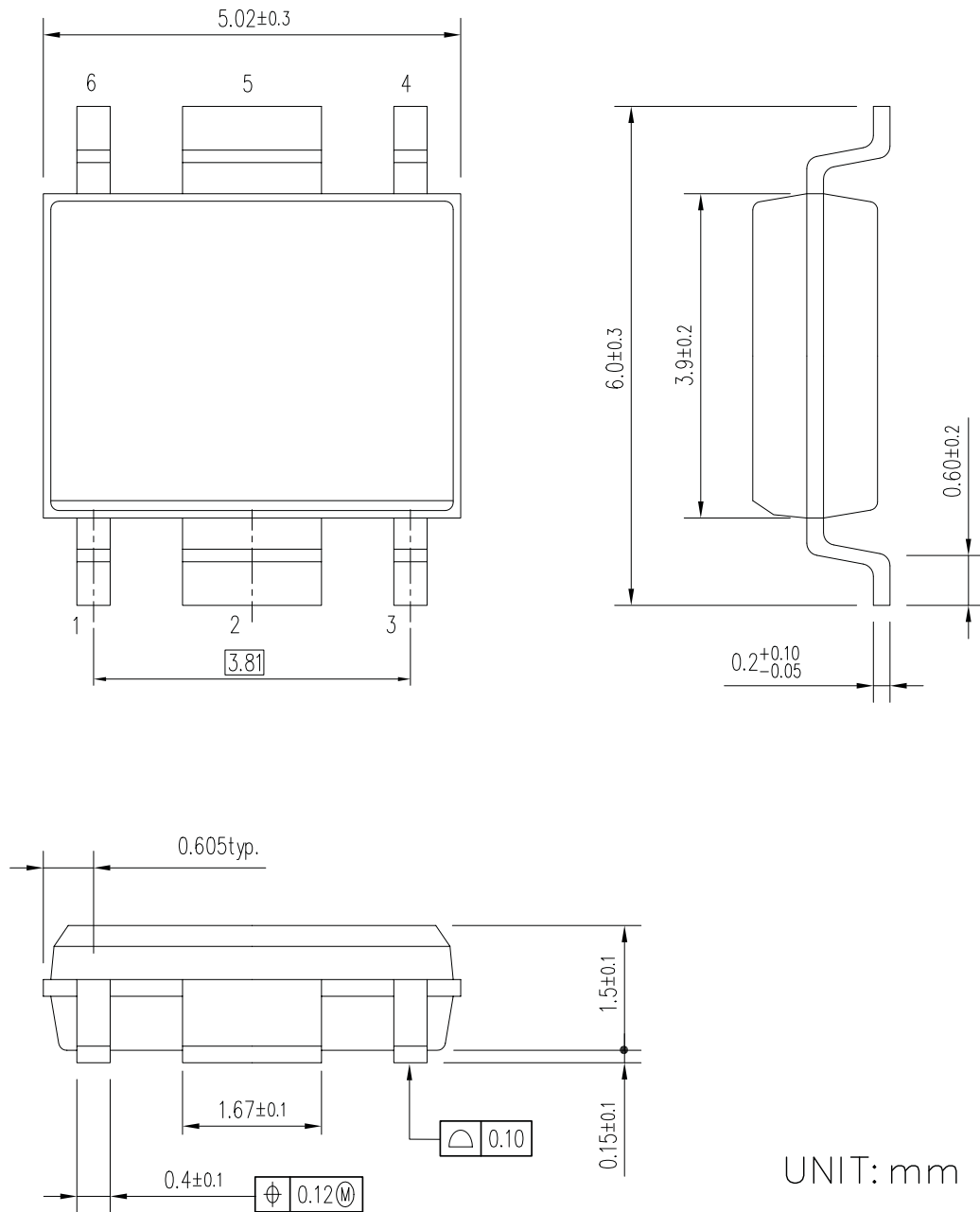
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

PACKAGE DIMENSIONS

HSOP-6J

Ver. A



HSOP-6J Package Dimensions

POWER DISSIPATION

TO-252-5

Ver. B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0. 4mm × 30pcs

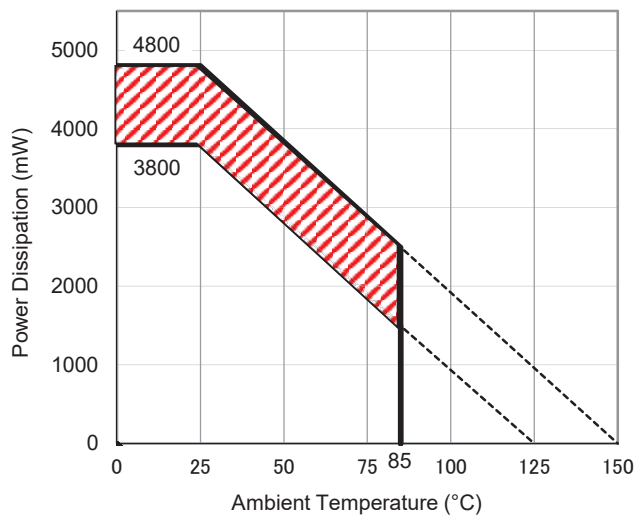
Measurement Result

(Ta = 25°C, Tjmax = 125°C)

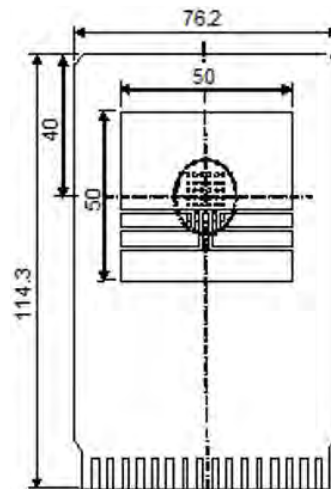
Item	Measurement Result
Power Dissipation	3800 mW
Thermal Resistance (θja)	θja = 26°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 7°C/W

θja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

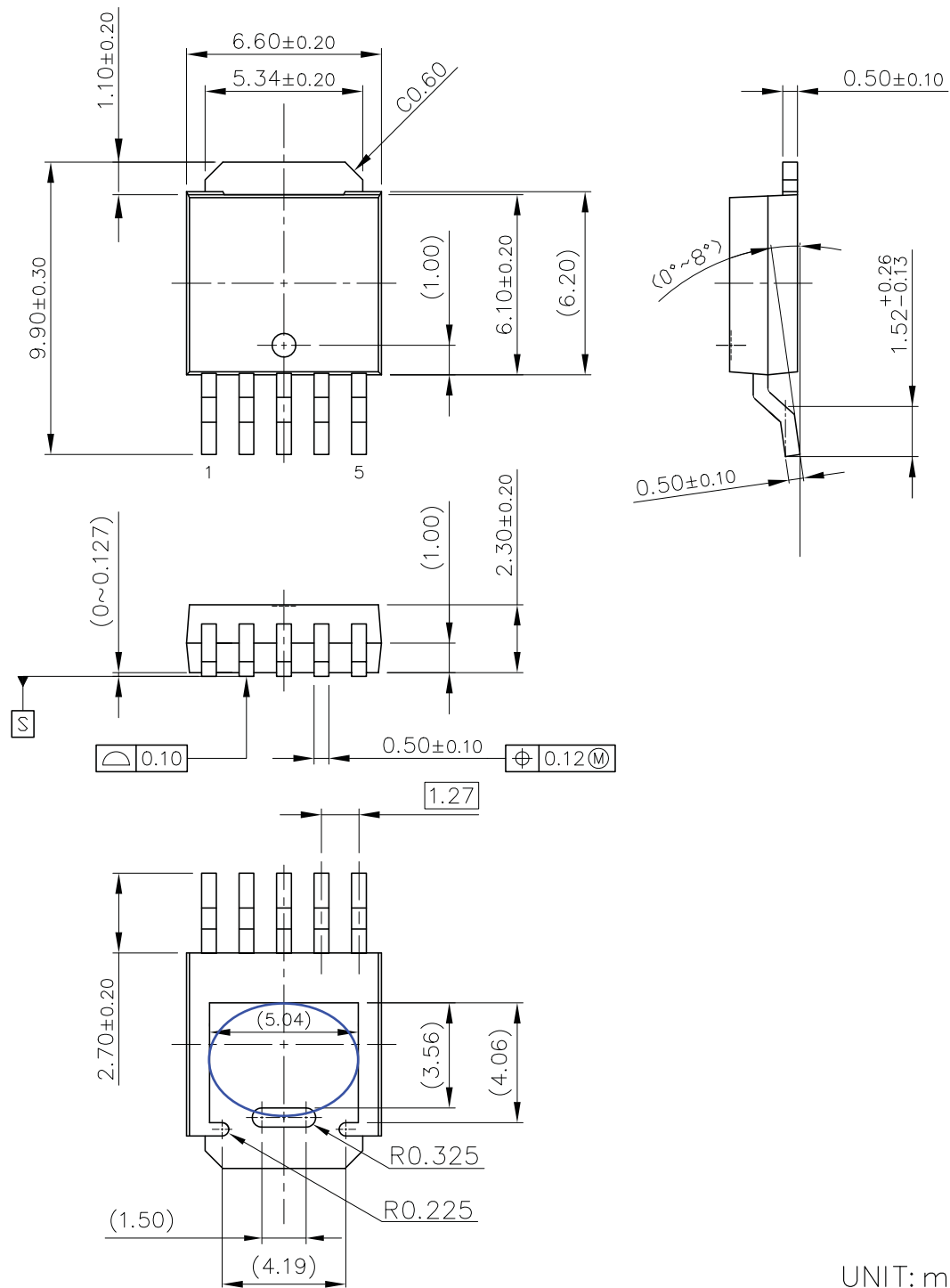
The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

PACKAGE DIMENSIONS

TO-252-5-P2

Ver. A



TO-252-5-P2 Package Dimensions

* The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane on the board but it is possible to leave the tab floating.

1. The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to our sales representatives for the latest information thereon.
2. The materials in this document may not be copied or otherwise reproduced in whole or in part without the prior written consent of us.
3. This product and any technical information relating thereto are subject to complementary export controls (so-called KNOW controls) under the Foreign Exchange and Foreign Trade Law, and related politics ministerial ordinance of the law. (Note that the complementary export controls are inapplicable to any application-specific products, except rockets and pilotless aircraft, that are insusceptible to design or program changes.) Accordingly, when exporting or carrying abroad this product, follow the Foreign Exchange and Foreign Trade Control Law and its related regulations with respect to the complementary export controls.
4. The technical information described in this document shows typical characteristics and example application circuits for the products. The release of such information is not to be construed as a warranty of or a grant of license under our or any third party's intellectual property rights or any other rights.
5. The products listed in this document are intended and designed for use as general electronic components in standard applications (office equipment, telecommunication equipment, measuring instruments, consumer electronic products, amusement equipment etc.). Those customers intending to use a product in an application requiring extreme quality and reliability, for example, in a highly specific application where the failure or misoperation of the product could result in human injury or death should first contact us.
 - Aerospace Equipment
 - Equipment Used in the Deep Sea
 - Power Generator Control Equipment (nuclear, steam, hydraulic, etc.)
 - Life Maintenance Medical Equipment
 - Fire Alarms / Intruder Detectors
 - Vehicle Control Equipment (automotive, airplane, railroad, ship, etc.)
 - Various Safety Devices
 - Traffic control system
 - Combustion equipment

In case your company desires to use this product for any applications other than general electronic equipment mentioned above, make sure to contact our company in advance. Note that the important requirements mentioned in this section are not applicable to cases where operation requirements such as application conditions are confirmed by our company in writing after consultation with your company.

6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
7. The products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this datasheet. Failure to employ the products in the proper applications can lead to deterioration, destruction or failure of the products. We shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of the products.
8. **Quality Warranty**
 - 8-1. **Quality Warranty Period**
In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
 - 8-2. **Quality Warranty Remedies**
When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.
Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
 - 8-3. **Remedies after Quality Warranty Period**
With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
9. Anti-radiation design is not implemented in the products described in this document.
10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
13. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



Nisshinbo Micro Devices Inc.

Official website

<https://www.nisshinbo-microdevices.co.jp/en/>

Purchase information

<https://www.nisshinbo-microdevices.co.jp/en/buy/>